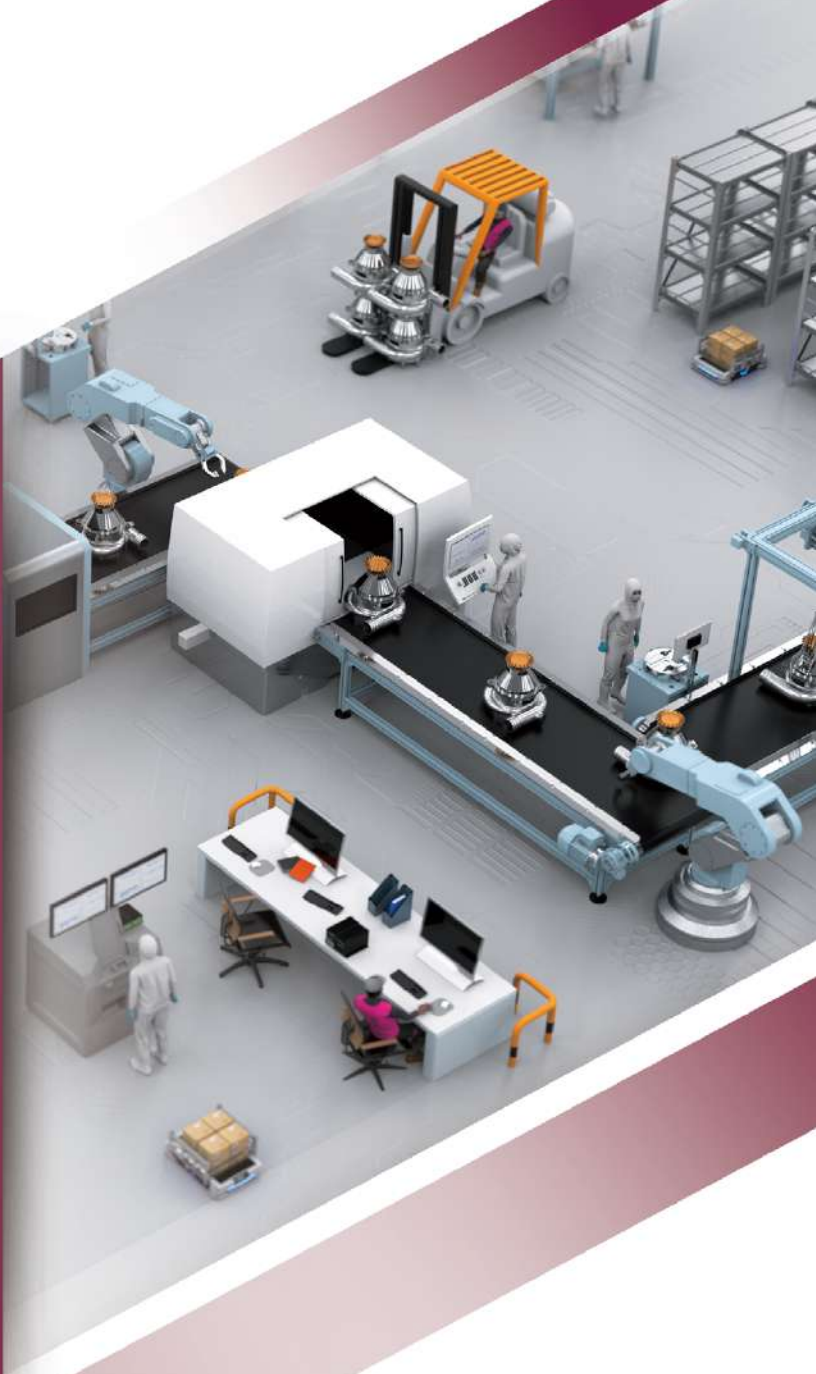




INDUSTRIAL COMPUTING  
SOLUTIONS FROM THE EDGE  
TO THE CLOUD

PRODUCT  
SOLUTION GUIDE

2026



BUILT RUGGED. BUILT READY.





# YOUR TOP CHOICE PARTNER IN INDUSTRIAL COMPUTING FROM THE EDGE TO THE CLOUD

Premio is a global solutions provider specializing in computing technology from the edge to the cloud. We design and manufacture highly reliable, world-class computing solutions for enterprises with complex, highly specialized requirements for over 35+ years. Our engineering specialty and agile manufacturing pushes the technical boundaries in Embedded IoT Computers, Rugged Edge Computers, HMI Displays, Panel PCs, and SuperCAP UPS Systems.

At Premio, we go to extraordinary lengths to solve the most formidable challenges faced by our customers. We do so by becoming more than their partner: we become their 'Inside Outsource' - an extension of their businesses, work cultures, manufacturing processes and operations, modulating our solutions to answer their special needs with speed, agility and precision.

Headquartered in Los Angeles, California, with a state-of-the-art manufacturing facility certified to ISO 9001, ISO 14001, and ISO 13485, Premio Inc. operates through strategic global locations—including a Taiwan facility certified to ISO 9001, ISO 14001, and IEC 62443-4-1.

With deep expertise in rugged product engineering, flexible speed-to-market, and end-to-end manufacturing transparency, Premio is committed to delivering next-generation industrial PC and edge AI solutions that meet the highest international standards and certifications—empowering customers across mission-critical industries.

- Industrial Automation
- Railway and Transportation
- Food & Beverage
- Military
- Kiosk & Retail
- Security & Surveillance
- Intelligent Healthcare
- Machine Vision & Robotics



## OUR MISSION

Premio dedicates its engineering resources and manufacturing services to meet the incredible demands of computing across industrial and enterprise deployments. Our global teams strive for the highest standards in innovation and technology that translates into the design and mass production of our purpose-built computing solutions.

## OUR VISION

"Your Success, Our Commitment." With this simple vision, Premio aims to address computing challenges with purpose-built products. Premio solves challenges for our customers by delivering solutions around the design, integration, validation, and deployment of our computing products in IoT and edge markets. Our 35+ years of industry-knowledge enable our customers to leverage high quality products and application-ready hardware for a faster time to market.

## OUR CORE VALUES

We deliver our core brand values through the way we conduct business. Premio's core values of Innovation, Commitment, Collaboration, Agility, and Accountability guide our decisions to exceed expectations.

### AGILITY

We are flexible, adaptable, and responsive to the change in demands of our customers, the market, and our environment. We are willing to learn and create new ideas to drive and embrace changes actively.

### INNOVATION

We constantly strive to drive innovation into all aspects of our business to provide products that deliver reliability, quality, performance, and value creation.

### COLLABORATION

We work together to contribute to the development of new products and services that will ensure the success of our customers.

### ACCOUNTABILITY

We always hold ourselves accountable for our products, services, and actions to our employees, customers, and partners.

### COMMITMENT

We offer our valued customers the highest possible standards of solutions. At Premio, we treat customers with dignity, respect, and courtesy. We listen objectively to their needs and respond in a timely, efficient, and responsible manner.



## OUR VALUE

Apart from our standard computing offerings, Premio also provides unique value to our customers through our robust engineering resources, environmental testing validation, manufacturing scale, supply chain & product lifecycle management, reverse logistics, and next generation computing design and innovation.





## US BASED COMPANY WITH WORLDWIDE OPERATIONS A STORY OF GROWTH & EVOLUTION

### ► 1989-2000

Premio, which means “Prize” in Spanish, emerged as “Premio PC”, a personal computer manufacturer providing computers nationwide to many educational programs (K-12) around the nation. From its inception in 1989 to 2000, Premio pioneered and remained a trusted partner and manufacturer for many educational institutions in the United States.

### ► 2000

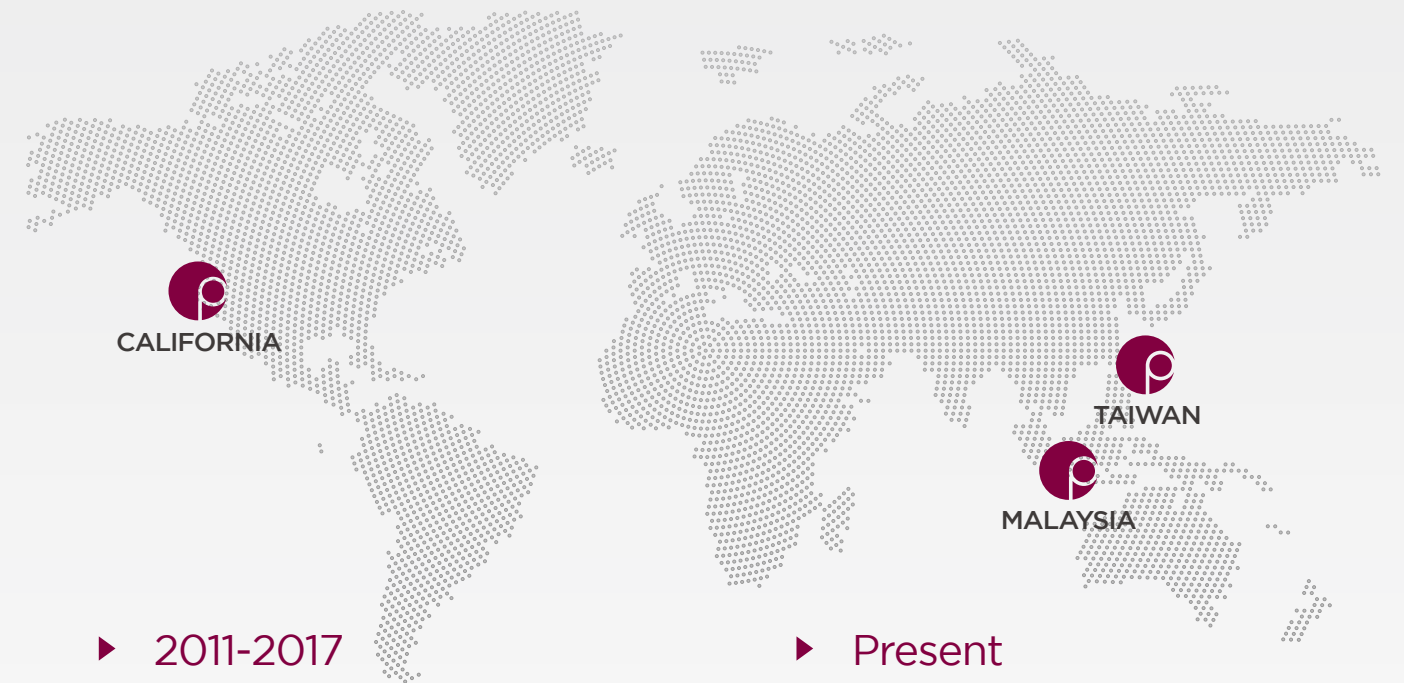
As computing technology advanced and became more commoditized, Premio proved to be resilient and achieved another milestone by evolving itself from its own personal computer in 2000 into a respectable contract manufacturer – providing a variety of highly specialized turnkey OEM integration processes and business services for some of the world’s elite computing companies; many of which still exist today in its global operations.

This monumental shift demanded Premio to move its operational infrastructure into a fully automated 150,000 square feet Los Angeles based manufacturing facility that was fully customized for ultimate flexibility and unlimited scalability. Even today Premio’s world-class manufacturing facility continues to be a testament for state-of-the-art automation and assembly for many leading OEMs in computing technology.

### ► 2000-2011

Starting from the year 2000, “Premio PC” transformed its brand identity into “Premio Inc.” – becoming a pivotal partner and key advisor in manufacturing and servicing premier technology companies around the world. Furthermore, Premio also restructured its mission and core values around a customer-centric business model with “total customer satisfaction” driving its core.

By 2010, Premio Inc. achieved yet another milestone by successfully engaging with over 50+ customers worldwide ranging from enterprise level companies to start-ups that were eventually acquired by major fortune 500 companies.



### ► 2011-2017

In 2011 Premio decided to once again refine its business operations and developed more advanced technologies by investing into the research and development of home grown purpose-built Premio products in:

- Enterprise Servers and Storage Solutions
- Industrial Embedded Computing Solutions
- Industrial Touch Display Solutions

By combining our home grown products with our design capabilities plus our renowned OEM services, Premio’s advantage lies within its ability in providing a customized turnkey solution that can scale efficiently but also seamlessly align with the goals of our customers, resulting in ROI growth and measurable success over time.

Premio expanded its global footprint with the establishment of a Taiwan facility in New Taipei City, strengthening its capabilities in R&D, product engineering, and manufacturing to scale worldwide delivery of industrial computing solutions.

### ► Present

Today, Premio has successfully evolved into a full-service technology company that specializes in top-notch computing designs, scalable manufacturing for both variety and volume, and robust end-to-end business services that result in streamlined growth and success with global expansion  
(Design – Manufacturing – Services)

2026 FEATURED INDUSTRIAL SOLUTIONS 12

INDUSTRIAL COMPUTERS 22

Premio's fanless embedded systems are extremely flexible and reliable to provide integrated solutions to meet different needs. With its superior features integration, exceptional system performance, flexible I/O connections, wide range power input, smart management functions, and rugged reliability, Premio fanless embedded systems deliver a compelling platform that is needed in today's demanding workloads and industrial needs.



BCO SERIES	24
SEMI-RUGGED INDUSTRIAL COMPUTERS	
RCO SERIES	28
SUPER-RUGGED INDUSTRIAL COMPUTERS	
ECO SERIES	38
SUPERCAPACITOR UPS BACKUP SYSTEM	
JCO SERIES	40
JETSON AI EDGE INDUSTRIAL COMPUTERS	
ACO SERIES	44
RAILWAY & IN-VEHICLE INDUSTRIAL COMPUTERS	

DCO SERIES	48
DIN RAIL FANLESS INDUSTRIAL COMPUTERS	
WCO SERIES	50
IP68/IP69K WATERPROOF INDUSTRIAL COMPUTERS	
VCO SERIES	52
MACHINE VISION INDUSTRIAL COMPUTERS	
KCO SERIES	54
WORKSTATION INDUSTRIAL COMPUTERS	
LLM SERIES	58
19" RACKMOUNT EDGE AI SERVER FOR ON-PREM LLM WORKLOADS	

INDUSTRIAL PANEL PCS AND TOUCH MONITORS 60

Premio's Industrial Panel PCs and Touch Monitors are purpose-built for the toughest embedded deployments requiring mission-critical reliability. System integrators and automation engineers can easily deploy Premio industrial panel PCs and touch monitors as human machine interfaces to achieve better productivity and operational efficiency in their enterprise projects.



FIO SERIES	62
IP65 OPEN-FRAME INDUSTRIAL TOUCHSCREEN MONITORS	
HIO SERIES	64
IP65 OPEN-FRAME INDUSTRIAL TOUCHSCREEN COMPUTERS	
AIO SERIES	66
IP65 ALL-IN-ONE INDUSTRIAL TOUCHSCREEN COMPUTERS & MONITORS	

VIO SERIES	70
IP65 MODULAR INDUSTRIAL TOUCHSCREEN MONITORS & COMPUTERS	
• DISPLAY MODULE • PC MODULE	
SIO SERIES	76
IP66/69K STAINLESS STEEL INDUSTRIAL TOUCHSCREEN COMPUTERS	

INDUSTRIAL BOARD SOLUTIONS

Premio offers industrial-grade scalability with standard motherboards and OEM system design. Standard form factors include:  
Single Board Computers (1.8" FEMTO-ITX, 2.5" PICO-ITX, and 3.5" SBCs), Mini-ITX, Micro-ATX, and ATX Boards.



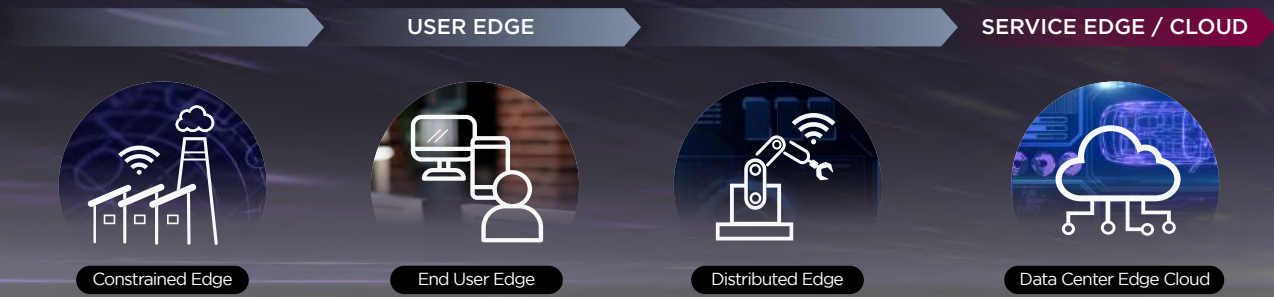
BOARDS SERIES	78
INDUSTRIAL BOARDS	



# THE EDGE CONTINUUM

## Industrial Edge Computer Series

The Edge Continuum spans a broad spectrum of computing solutions, from the remote constrained edge to the cloud edge servers, enabling instant data analytics, seamless connectivity, and robust control across all layers of industrial operations. Our Industrial Computers and Panel PCs seamlessly integrate within the “User Edge,” where low-latency computing and industrial-grade durability are paramount. Our computing solutions are segmented into three layers within the User Edge Continuum—Industrial Edge, Rugged Edge, and Specialized Edge.



### Industrial Edge

- Controlled Environments
- Fanless Cooling Design
- Dust, Shock, and Vibration Resistant
- Standardized Form Factors
- Durable and Cost-Effective
- Long Lifetime Support

#### BCO Series Fanless Industrial Computers



The BCO series provides a comprehensive range of computing power, making it ideal for diverse industrial edge applications that require reliable, dust-resistant, and long-lifespan solutions.

### Rugged Edge

- Extreme Environments
- Wide Operating Temperature
- Powerful Computing Capabilities
- Supports EDGEBoost Technology for I/O, M.2, and PCIe Customization
- Reinforced Durability

#### RCO Series Super-Rugged Computers



The RCO series is engineered for ultimate industrial durability and unparalleled customizability, creating a unique blend of ruggedness and flexibility.

#### JCO Series Jetson EDGE AI Computers



The JCO series, powered by the NVIDIA Jetson platform, delivers an optimal balance of energy efficiency and AI performance, achieving high throughput (TOPS) in a fanless design built for extreme industrial environments.

### Specialized Edge

- Designed for Industry-Specific Needs
- Validated with Niche Certifications
  - EN50155 (Railway)
  - EN45545 (Fire Safety)
  - E-Mark (In-Vehicle)
  - IP68/IP69K (Waterproof)

#### DCO Series DIN RAIL Fanless Computers



#### WCO Series IP68/IP69K Waterproof



#### ACO Series EN50155 Railway & In-Vehicle



#### VCO Series Machine Vision GPU Computers

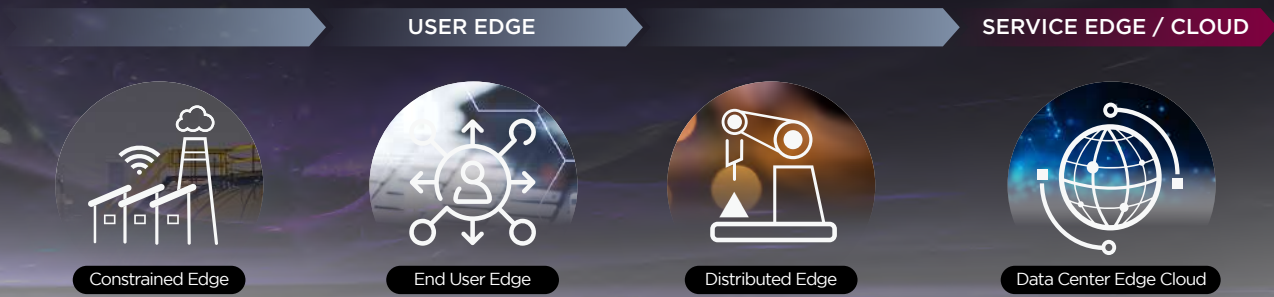


#### KCO Series Rackmount Industrial Computers



## DELIVER INTELLIGENCE AT THE END USER EDGE

Our touchscreen computer series are available across the three User Edge segments, providing a wide variety of options for end-user applications. Additionally, the displays on our touchscreen computers (Panel PCs) can be configured with multiple optional features, such as PCAP or resistive touch, optical bonding, high-brightness 1000+ nits displays, and various mounting options. Our Panel PCs are available in sizes ranging from 10" up to 24" with 4:3 and 16:9 Full HD displays. Explore each Panel PC series to discover the unique features each solution offers.



### Industrial Edge

- Controlled Environments
- Flexible Performance
- Fanless Cooling Design
- IP65 Front Display
- 10"-21" Full HD Displays
- Extended MTBF

#### AIO Series All-In-One Touchscreen Computers



The AIO Series is an all-in-one touchscreen computer designed to deliver efficient edge computing through its Intel X86 and Rockchip platforms, supporting various operating systems including Windows, Linux, and Android.

#### HIO Series Open-Frame Touchscreen Computers



The HIO Series is an open-frame touchscreen computer with versatile I/O and connectivity options. The HIO Series leverages power-efficient X86 Intel platforms for various kiosks and open-frame mounted applications.

### Rugged Edge

- Industrial Environments
- Various Computing Capabilities
- Wide Temperature Range
- Shock & Vibration Resistant
- Reinforced Durability
- Fit for Demanding Edge Applications

#### VIO Series Modular Touchscreen Monitors & Computers



The VIO Series is a unique, modular IP65 touch display system that allows VIO displays to be configured as either a touchscreen computer or a touchscreen monitor. VIO displays can be paired with different modules for monitor (MX Series) or computer (PC Series) functionality.

#### MX Series



#### PC Series



### Specialized Edge

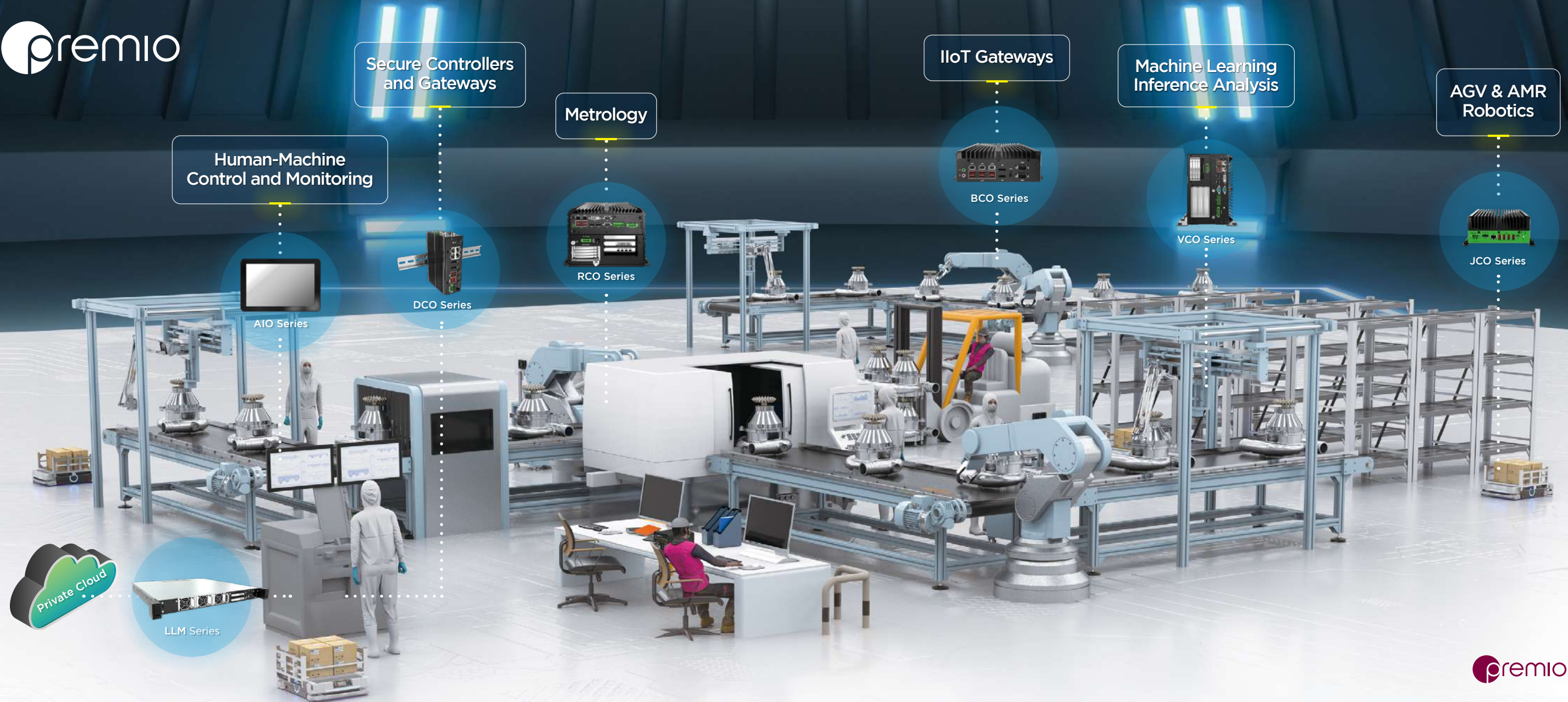
- Tailored for Industry-Specific Needs
- Includes IP66/IP69K Waterproof, SUS-316 Stainless Steel, and Optical Bonding
- Targeted Functionality for Specialized Applications

#### SIO Series Stainless Steel Touchscreen Computers



The SIO Series is an IP66/IP69K-rated Panel PC built with full SUS-316 stainless steel construction, offering superior waterproof and corrosion-resistant protection during intense washdowns.





## Edge Computing Powering AI Factories

### Rugged, reliable systems built for automation

The AI Factory merges intelligence, automation, and data into a self-learning ecosystem that turns sensor inputs into real-time action. Powered by edge and on-prem AI inference, it connects the physical and digital worlds to drive smarter, faster, and more resilient manufacturing.

#### Benefits of Edge-Native Intelligence



Immediate decisions with zero cloud latency



Localized security to protect sensitive data



Continuous operation even during network outages



Systems that adapt and learn in real-world conditions

## Key Technologies in AI Factories

Intelligence is built through connected layers working together to power smart, autonomous operations.

### AI Inference

#### Powering Real-Time Intelligence

At the core of every AI Factory lies inference — where trained models analyze real-time data to generate decisions and predictions. This is where intelligence becomes action.

### Testing and Digital Twins

Before deployment, agentic AI systems are trained and optimized through digital twins—data-driven replicas of factory environments that simulate and predict real-world operations

### Automation and Orchestration

Manages and secures distributed AI systems after deployment, ensuring consistent performance and lifecycle control across edge nodes.



# PHYSICAL AI

## Edge Intelligence for Robotics & Autonomous Systems

- AMR / AGV Navigation
- Robotics & Cobot Vision
- Multi-Sensor Fusion
- High-Speed Inspection
- VLMs & SLMs



### JCO-6000-ORN Series

High-Performance AI Edge Computer with NVIDIA Jetson AGX Orin Processor

**275 TOPS**  
AGX Performance

**4x PoE**  
RJ45 or M12

**Jetpack 6**  
Support Latest Jetpack

**CAN**  
CAN 2.0 and Power Ignition

### JCO-3000-ORN Series

Mid-Range AI Edge Computer with NVIDIA Jetson Orin NX/ Nano Processor

Entry-Level AI Edge Computer With NVIDIA Jetson Orin Nano & NX Processor

**157 TOPS**  
Super Mode

**2x**  
RJ45/ M12 LAN

**EDGEBoost I/O**  
Modular I/O Expansions

**8x**  
GMSL2 Cameras

**COM, DIO**  
RS 232/422/485 8 in/out (Isolated)

**4x**  
LAN or PoE

**Mini**  
150 x 105 x 65 mm (W x D x H)

**4x**  
GMSL2 Cameras

On-Prem LLM Inference  
Multimodal AI Agents  
AI Workflows & Pipelines  
Private Data Analytics  
RAG / Enterprise Knowledge AI



# LLM & ON-PREM AI

Local AI Inference for Privacy, Speed, and Control

## LLM-1U-RPL Series LLM Series EDGE AI Rackmount Servers with Intel® 12<sup>th</sup>/13<sup>th</sup>/14<sup>th</sup> Gen

**1U**  
Short-Depth Rackmount

**RTX™ 5000 Ada**  
600W GPU Power Budget

**2x**  
Hot-Swap SSDs

**600W**  
Dual Redundant Power Supplies

## KCO-6000-ARL Series Edge Work-Station with Intel® Arrow Lake CPU

**GEN 5**  
PCIe Generation

**Blackwell**  
600W GPU Power Budget

**DDR5**  
High-Speed Memory

**Arrow Lake**  
Core Ultra Series 2



# RAILWAY & ROLLING STOCK

Certified Computing for Train Control & Passenger Systems



EN50155 Railway Certified

## ECO-1000 Series

EDGEBoost EnergyPack:  
Industrial-Grade  
Supercapacitor UPS

**EN50155**  
Railway EMC Certified

**200W**  
Power  
Output

**10+**  
Years Longevity

**Smart**  
Remote  
Management

## ACO-6000-RPL Series

Railway & In-Vehicle Fanless  
Computer with Intel®  
12<sup>th</sup>/13<sup>th</sup>/14<sup>th</sup> Gen CPU

**EMC Conformity**  
EN50155 & EN50121-3-2

**8x**  
M12 or RJ45

**2x**  
EDGEBoost I/O  
Modular I/O Technology

**2x**  
Hot-Swap  
SSDs

## ACO-3000-ORN Series

Railway & In-Vehicle Fanless  
Computer with NVIDIA Jetson  
Orin NX and Nano

**IP66**  
Water-Resistant

**4x**  
GMSL  
Cameras

**157 TOPS**  
SUPER Mode

**4x**  
M12 PoE



# IN-VEHICLE COMPUTING

Rugged Systems for Transport,  
Fleet, and Mobility



## RCO-1000-ASL Series

Super-Rugged Fanless Mini Computer  
with Intel® Amston Lake Series

**3x EDGEBoost I/O**  
Modular I/O Technology

**-40°C to 70°C**  
Extreme Operating Temperature

**MIL-STD-810H**  
Shock & Vibration Compliance

## RCO-3000-RPL Series

Super-Rugged Fanless SFF Computer  
with Intel® Raptor Lake & Bartlett Lake  
Processors

**1x EDGEBoost I/O**  
Modular I/O Technology

**-25°C to 70°C**  
Extreme Operating Temperature

**EMC Conformity**  
with EN50155 & EN50121-3-2

## RCO-6000-RPL Series

Super-Rugged Fanless Computer with  
Intel® Raptor Lake & Bartlett Lake  
Processors

**2x EDGEBoost I/O**  
Modular I/O Technology

**-25°C to 70°C**  
Extreme Operating Temperature

**EDGEBoost Nodes**  
Flexible GPU and NVMe SSD Expansions





# MACHINE VISION

## Real-Time Detection and High-Speed Optical Inspection

- Automated Optical Inspection (AOI)
- Industrial Quality Control
- 3D Vision & Measurement
- Robotics Vision Guidance
- Sorting & Counting Systems



**VCO-6000-RPL Series** [Visit P.53](#)  
Machine Vision Industrial Computer with Intel® Raptor Lake and Bartlett Lake

**KCO-3000-RPL Series** [Visit P.56](#)  
Short-Depth Industrial Workstation with Intel® 12<sup>th</sup>/13<sup>th</sup>/14<sup>th</sup> Gen Processors



600W  
GPU Power Budget

4x  
PCIe Gen 4 Slots

FLFH  
GPU Support



500W  
Internal Flex Power Supply

4x  
PCIe Gen 4 Slots

3U  
Rackmount



# SMART CITY / SURVEILLANCE & AIRPORTS

- AI Video Surveillance
- Traffic & Tolling Systems
- Crowd Management
- Perimeter Detection
- Airport Analytics & Security



## Edge AI for Safety, Monitoring, and Operational Efficiency

BCO-500-MTL Series	BCO-500-ROK Series	DCO-1000-ASL Series	RCO-6000-RPL-4N-1E Series
Semi Rugged Fanless Mini Computer with Intel® Meteor Lake Core Ultra Series	Semi Rugged Fanless Mini Computer with Rockchip RK3568J Processor	DIN-Rail Fanless Industrial Computer with Intel® Amston Lake Series	Super-Rugged Industrial Computer with EDGEBoost Node Expansion for Edge AI
Mini 225 x 130 x 48 mm	Mini 225 x 130 x 48 mm	DIN DIN Rail Mount	4x Hot-Swap NVMe
11 TOPS Discrete NPU	1 TOPS Discrete NPU	4x 2.5 GbE LAN	3x PCIe Slots
3x 2.5 GbE LAN	5W Ultra Low Power	OOB Out-of-Band Management	10x LAN Support 8x PoE
USB-C 1x Type-C, 3x Type-A	-40 to 70°C Extreme Operating Temperature	UL61010 Safety Certifications	RAID RAID 0/1/5/10



# KIOSK & RETAIL SYSTEMS

Secure, Reliable Computing for Interactive Self-Service

- AI Agent Service Kiosks
- POS / Retail Automation
- Inventory & Shelf Monitoring
- Smart Vending & Ticketing
- Digital Signage



Screen Sizes 10.1"~21.5"

## AIO-200-ASL

Series

IP65 All In One Touchscreen Computer  
with Intel® N97 or X7835RE Processor

## HIO-200-ADL

Series

IP65 Open Frame Touchscreen Computer  
with Intel® Alder Lake N97 Processor

**SLIM**  
5 cm Thickness

**3x**  
2.5 GbE LAN

**5G**  
High-Speed  
Wireless

**Open Frame**  
Mount Design

**DDR5**  
16GB Memory

**2x**  
2.5 GbE

# RUGGEDIZED PANEL PC

Industrial Touch Interfaces for  
Harsh Environments



- Factory HMI & SCADA
- Food & Beverage Processing
- Outdoor Terminals
- Warehouse Workstations
- Cleanroom & Pharma Control

## VIO/PC600-MTL Series

Modular IP65 Industrial Panel PC with Intel®  
Meteor Lake Core Ultra 5 125U CPU

## SIO-300-ADL Series

IP69K Stainless Steel Panel PC with Intel®  
Alder Lake CPU

**12.1"~23.8"**  
Flexible Display Module

**4x**  
M.2 Expansions

**15"~23.8"**  
FHD Displays

**SUS 316**  
Corrosion Resistant

**Modular**  
Display + PC Modules

**PCIe**  
1x PCIe x4 Slot

**Optical Bonding**  
For Clarity and Longevity

**M12**  
Waterproof I/O



# 3.5" INDUSTRIAL SBC

Compact Embedded Boards  
for OEM Systems

Embedded  
Controllers

Portable  
Devices

Industrial  
Gateways

Edge AI Data  
Acquisition



**CT-DAS01 Series** [Visit P.80](#)  
3.5" SBC with Intel® Amston Lake Series

- 40°C to 85°C**  
Wide Operating Temperature
- Type-C**  
1x Type-C, 3x Type-A
- 2x**  
Displays (HDMI, DP)
- 2x**  
2.5 GbE

**CT-DML01 Series** [Visit P.80](#)  
3.5" SBC with Intel® Meteor Lake Series Ultra 5 125U / Ultra 7 155U

- 11 TOPS**  
AI Performance with NPU
- Type-C**  
1x Type-C, 3x Type-A
- 2x**  
Displays (DP)
- M.2**  
E, B, M Keys

# INDUSTRIAL BOARDS

Full-Featured Motherboards  
for Performance-Driven Designs

- Industrial PCs
- AI Edge Systems
- Edge Servers & Workstations
- Medical & Laboratory Devices
- Factory Automation Systems



**CT-XAR01 Series** [Visit P.81](#)

Mini-ITX Industrial Board  
with Intel® Arrow Lake Series

- LG1851**  
65W TDP
- W880**  
Chipset
- 3x**  
2.5 GbE
- PCIe Gen 5**  
High-Speed Expansion

**CT-AR701 Series** [Visit P.83](#)

ATX Industrial Board  
with AMD Ryzen EPYC Series

- AM5**  
170W TDP
- B650**  
Chipset
- SFP+**  
2x GbE, 2x 10GbE SFP
- PCIe Gen**  
High-Speed Expansion



# INDUSTRIAL EDGE COMPUTERS



**BCO** SERIES  
SEMI-RUGGED INDUSTRIAL  
COMPUTERS



**JCO** SERIES  
JETSON AI EDGE  
INDUSTRIAL COMPUTERS



**DCO** SERIES  
DIN RAIL FANLESS  
INDUSTRIAL COMPUTERS



**VCO** SERIES  
MACHINE VISION  
INDUSTRIAL COMPUTERS



**ECO** SERIES  
SUPERCAPACITOR UPS  
BACKUP SYSTEM



**RCO** SERIES  
SUPER-RUGGED  
INDUSTRIAL COMPUTERS



**ACO** SERIES  
RAILWAY & IN-VEHICLE  
INDUSTRIAL COMPUTERS



**WCO** SERIES  
IP68/IP69K WATERPROOF  
INDUSTRIAL COMPUTERS



**KCO** SERIES  
FANNED INDUSTRIAL  
COMPUTERS



**LLM-1U** SERIES  
1U EDGE AI  
RACKMOUNTABLE SERVER

## EDGEBoost TECHNOLOGIES

### EDGEBoost Nodes

EDGE AI PERFORMANCE  
ACCELERATORS MODULES

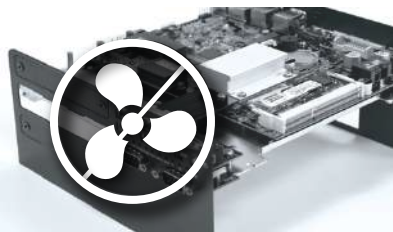
EBND SERIES



### EDGEBoost I/O

FLEXIBLE I/O AND M.2  
EXPANSION MODULES

EBIO SERIES



#### FANLESS DESIGN

- Prevent failure/repair/replacement caused by fan part
- Venting holes no longer needed
- Extended MTBF
- No noise



#### ONE-PIECE DESIGN

- Robust structure
- Less joint parts and screws for higher shock & vibration tolerance
- Easy assembly, disassembly, maintenance
- Sealed housing to prevent dust



#### POWER PROTECTION

- Over voltage protection
- Over current protection
- Reverse protection



#### SHOCK & VIBRATION

Fanless computing systems comply with MIL-STD 810H on shock & vibration in order to sustain in environments such as industrial automation, transportation, military, etc.



#### EXPANDABLE & MODULARIZATION

The modular design approach helps with the ease of installation to achieve rapid deployment, and provide wide variety of configurable options to achieve scalability.



#### EXTENDED OPERATING TEMPERATURE RANGE

Premio fanless embedded systems support extended temperature to allow applications to function in difficult and harsh environment.

#### COMMITMENT TO INDUSTRIAL CYBERSECURITY

We have achieved IEC 62443 certification, reflecting our dedication to implementing and maintaining the highest standards of cybersecurity in industrial automation and control systems. This certification demonstrates our ongoing commitment to safeguarding critical infrastructure and delivering secure, reliable solutions.

**IEC 62443-4-1**  
Cybersecurity



#### INDUSTRY LEADING SAFETY CERTIFICATIONS

Tested and validated with safety certifications ensure product reliability against safety hazards and allow customers to comply with industry-specific regulatory requirements.



EN50155 &  
EN45545





# BCO SERIES



## SEMI-RUGGED INDUSTRIAL COMPUTERS

500  
Mini

1000  
Compact

3000  
Balanced  
Performance

6000  
High  
Performance

- Intel® Atom® / Core Ultra / Rockchip Processors
  - Mini Form Factor
  - High-Speed I/O Ports and Wireless Connectivity
- Intel® Alder Lake / Intel® Atom® Processors
  - Power Efficient 12W Performance
  - Competitive Price and Long Lifetime Support
- Intel® Core Processors
  - Powerful 35W Edge Performance
  - Up to Triple Displays / Triple RJ45 LAN Ports
- Intel® Core Processors
  - Powerful 35W Edge Performance
  - 2x PCIe Gen 4 Slots with GPU Support

## REAL-TIME DATA PROCESSING FOR RUGGED EDGE COMPUTING

The BCO Series are designed and built to withstand deployment in challenging environments, managing workloads at the rugged edge for processing, storage, connectivity, and machine learning. Available in four series, the BCO-500, BCO-1000, BCO-3000, and BCO-6000 Series are capable of accommodating various edge workloads from power efficient computers to scalable GPU computers.

Deployment Ready Solution






Support Expandable GPU

Fast Time To Market

Compact & Ruggedized Design

## SEMI-RUGGED FANLESS MINI INDUSTRIAL COMPUTERS

### BCO-500 SERIES [MORE](#)

<div></div>	<div></div>			
Model	BCO-500-ROK	Model	BCO-500-ADL	BCO-500-MTL
Processor	Rockchip RK3568J ARM Quad Cortex-A55, up to 2.0GHz	Processor	Intel® Alder Lake-N: N97 (12W) / i3-N305 (15W)	Intel® Core™ Ultra 5 125U / Ultra 7 155U (15W)
Memory	4GB LPDDR4 2133MHz	Memory	1x DDR5-4800 SO-DIMM, Max. 16GB	1x DDR5-5600 SO-DIMM, Max. 32GB
Storage	64GB eMMC, MicroSD	Storage	1x M.2 B-Key (SATA/PCIe x1)	1x M.2 M-Key (PCIe Gen4 x4 / SATA, default 128GB)
Display	1x HDMI (4096 x 2160 @60Hz)	Display	1x DP 1.4a + 1x HDMI 1.4b (dual independent)	2x DP++ 1.4 (3040 x 2160 @60Hz, dual independent)
Graphics /AI	Mali-G52 GPU	Graphics /AI	Intel® UHD Graphics	Intel® Graphics
LAN	2x GbE (RTL8211FDI)	LAN	2x 2.5GbE (Intel® I225-V)	3x 2.5GbE (Intel® i226-V/LM)
I/O Ports	2x USB 3.0, 2x COM, 1x CAN, Line-Out	I/O Ports	4x USB 3.2 Gen2, 2x COM, Line-Out	1x USB-C, 2x USB 3.2 Gen1, 1x USB 2.0, 2x COM, Line-Out+Mic
Expansion	1x M.2 B-Key (4G/LTE), 1x M.2 E-Key (Wi-Fi/BT), SIM	Expansion	1x M.2 B-Key (SATA/NVMe storage), 1x M.2 E-Key (Wi-Fi/BT), 6x antenna holes	1x M.2 B-Key (4G/5G/NVMe), 1x M.2 E-Key (Wi-Fi/BT), SIM
Operating System	Android 13, Linux Kernel: Debian 11, Ubuntu 22.04	Operating System	Windows 10/11, Linux Kernel (Ubuntu LTS)	
Power Input	12-24V DC, AT/ATX modes	Power Input	12-36V DC, AT/ATX modes	12-24V DC, includes 150W adapter
Operating Temp	-40°C to 70°C	Operating Temp	-10°C to 50°C (N97) -10°C to 45°C (N305)	-20°C to 60°C
Certifications	UL 61010-1/-2-201, CE, FCC A, UKCA, IC	Certifications	UL 61010-1/-2-201, CE, FCC A, UKCA, VCCI, RCM	UL 62368-1, CE, FCC A, UKCA
Dimensions (WxDxH)	225 x 130 x 41 mm	Dimensions (WxDxH)	225 x 130 x 41 mm	225 x 130 x 48 mm
Weight	1.2kg	Weight	1.2kg	2.0kg



BCO-1000-ADLN

SERIES

MORE



Model	BCO-1000-ADLN_2L	BCO-1000-ADLN-B_3L
Processor	Intel® Alder Lake-N N97, 4 cores, 12W	Intel® Alder Lake-N N97 (4C, 12W) or Intel® Atom® x7835RE (8C, 12W)
Memory	DDR5-4800 SO-DIMM, Max. 16GB	
Graphics	Intel® UHD Graphics	
Display	1x DP 1.4a (4096 x 2304 @60Hz), 1x HDMI 1.4b (3840 x 2160 @30Hz), dual independent	
Storage	1x M.2 B-Key (Default 128GB SSD), 1x 2.5" SATA bay	1x M.2 B-Key (LTE/4G/5G/Storage), 1x 2.5" SATA bay
I/O Ports	2x COM, 2x USB 3.2 Gen2, 2x USB 3.2 Gen1, 2x USB 2.0, Line-in/out/Mic	2x COM, 2x USB 3.2 Gen1, 2x USB 2.0, Line-in/out/Mic
LAN	2x 2.5GbE (Intel® I225-V)	3x 2.5GbE (I225-V; one co-lay with I226-LM/TSN)
Expansion	1x M.2 E-Key (Wi-Fi/BT, CNVi)	1x M.2 B-Key + 1x M.2 E-Key
SIM Support	-	Dual SIM Sockets
GPIO	1x 8-bit Digital I/O	
Operating System	Windows 10/11, Linux Kernel (Ubuntu LTS)	
Power Input	9-36V DC, AT/ATX modes	12-36V DC, AT/ATX modes
Operating Temp	0°C to 50°C	
Dimensions (WxDxH)	192 x 140 x 68 mm	

BCO-3000-RPL

SMALL FORM FACTOR

MORE



BCO-6000-RPL

INDUSTRIAL COMPUTER

MORE

Model	BCO-3000-RPL		BCO-6000-RPL	
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i9/i7/i5/i3 (35W TDP, LGA 1700)			
Chipset	Intel® Q670E			
Memory	2x DDR4-3200 SO-DIMM, up to 64GB			
Graphics	Intel® UHD Graphics			
Display	2x DP 1.4a, 1x HDMI 1.4b (triple independent)			
Validated GPU	-		1x PCIe x16 or 2x PCIe x8 (supports RTX 2000 ADA, RTX 4000 SFF ADA)	
Storage	1x M.2 M-Key (NVMe, default 128GB), supports B+M Key			
Expansion	1x M.2 B-Key (5G/4G/LTE, SIM), 1x M.2 E-Key (Wi-Fi/BT)			
I/O Ports	4x COM, 6x USB 3.2 Gen2, 2x USB 3.2 Gen1, 2x USB 2.0, Line-out/Mic			
LAN	3x 2.5GbE (Intel® I226)			
Digital I/O	8-in / 8-out isolated DIO			
Operating System	Windows 10/11, Linux Kernel (Ubuntu LTS)			
Power Input	9-36V DC, AT/ATX			
Operating Temp	0°C to 50°C (35W CPU)			
Dimensions (WxDxH)	192 x 240 x 69 mm		330 x 240 x 69 mm	



# RCO SERIES



## SUPER-RUGGED INDUSTRIAL COMPUTERS

1000

Ultra Compact

- Intel Atom® Processors
- Up to 3x EDGEBoost I/O
- Lite AI Performance
- Up to 2x PoE and 2x LAN RJ45
- Wide Operating Temperature -40°C up to 70°C

3000

Small Form Factor

- Intel® Core Processors
- 1x EDGEBoost I/O
- Mid-AI Performance
- Up to 4x PoE RJ45/M12
- Wide Operating Temperature -25°C up to 70°C
- EN50155 (EMC) Certified

6000

High Performance


- Intel® Core Processors
- 2x EDGEBoost I/O
- High-AI Performance
- Up to 8x PoE RJ45/M12
- EDGEBoost Nodes Compatible for SSD, GPU and PCIe expansions
- Wide Operating Temperature -25°C up to 70°C

## PERFORMANCE, EXPANDABILITY, AND DURABILITY AT THE RUGGED EDGE


The RCO Series is a line of super-rugged x86 industrial computers purpose-built to enable real-time performance in extreme deployments. By leveraging a fanless and cableless design approach with modular EDGEBoost technologies, these systems can provide seamless configurability to meet varying edge-native deployment requirements while maintaining utmost durability. Available in three series, the RCO-1000, RCO-3000, and RCO-6000 Series.




EDGEBoost I/O Support



EDGEBoost Nodes Support



Scalable NVMe, SATA, and RAID Card



Scalable Robust GPU Cards

## ULTRA COMPACT RUGGED COMPUTER

### RCO-1000-ASL SERIES





Coming Soon



Coming Soon



Coming Soon

Model	RCO-1000-ASL-10	RCO-1000-ASL-20	RCO-1000-ASL-30
Processor	x7835RE (8 cores, up to 3.6GHz) Intel® Atom® x7433RE (8 cores, up to 3.4GHz)		
Memory	1x DDR5 SODIMM, Max. 16GB		
Out-of-Band Management	Support OOB Module (2x COM, 1x RJ45)		
Display	1x DisplayPort (4096x2304 @60Hz), 1x HDMI 1.4b (3840x2160 @30Hz), dual display		
Storage	1x 2.5" SATA bay, 1x M.2 B-Key (Storage)	1x 2.5" SATA bay, 1x M.2 B-Key (4G/5G/AI/Storage)	
I/O Ports	2x COM (RS-232/422/485), 3x USB 3.2 Gen2, 1x USB 2.0, Audio		
LAN	2x 2.5GbE (Intel® I226, WoL & PXE)		
Expansion	1x M.2 E-Key (Wi-Fi/BT)		
EDGEBoost I/O	1x EBIO Expansion	2x EBIO Expansion	3x EBIO Expansion
Power Input	9-36V DC, AT/ATX modes, ignition sensing supported		
Operating Temp	-40°C to 70°C		
Dimensions (WxDxH)	150 x 105 x 49 mm	150 x 105 x 65 mm	150 x 105 x 83 mm

### RCO-1000-EHL SERIES [MORE](#)





Model	RCO-1000-EHL-10	RCO-1000-EHL-20	RCO-1000-EHL-30	RCO-1000-EHL-30-2P
Processor	Intel® Atom® X6425E (Elkhart Lake), Quad-Core, 1.8GHz			
Memory	1x DDR4 SODIMM, Max. 32GB			
AI Acceleration	Supports 1x Hailo-8™ (26 TOPS)			
Display	2x DisplayPort 1.4 (4096 x 2160 @60Hz, dual display)			
Storage	1x 2.5" SATA bay, 1x mSATA			
I/O Ports	2x COM (RS-232/422/485), 3x USB 3.2 Gen2, 1x USB 2.0, Audio			
LAN	1x 2.5GbE + 1x 1GbE (Intel® I225/I210, WoL & PXE)			1x 2.5 GbE, 1x GbE, 2x PoE
Expansion	1x Full-size mini PCIe, 1x M.2 B-Key (5G/4G/AI Module), 2x SIM			
EDGEBoost I/O	1x EBIO Expansion	2x EBIO Expansion	3x EBIO Expansion	3x EBIO Expansion
Power Input	9-36V DC, AT/ATX modes, ignition sensing supported			
Operating Temp	-40°C to 70°C			-40°C to 50°C
Dimensions (WxDxH)	150 x 105 x 49 mm	150 x 105 x 65 mm	150 x 105 x 83 mm	



RCO-3000-RPL

MORE

RCO-6000-RPL SERIES

MORE



Model	RCO-3000-RPL
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> /Core 200S Gen Intel® Core™ i3 to i9 (45W/35W TDP, LGA 1700)
Chipset	Intel® Q670E
Memory	1x DDR5 SODIMM, Max. 32GB
Graphics	Intel® UHD Graphics
AI Accelerator Support	Supports up to 4x Hailo-8™ AI modules
Display	4x DP 1.4a (4 independent displays)
Storage	2x 2.5" SATA bays (1 internal, 1 hot-swap), RAID 0/1/5
Expansion	2x M.2 B-Key (NVMe/AI/4G/5G), 1x M.2 E-Key
EDGEBoost I/O	1x EDGEBoost I/O Expansion
I/O Ports	3x COM (external) + 2x COM (internal), 6x USB 3.2 Gen2
LAN	2x 2.5GbE (Intel® I226, TSN)
Digital I/O	8-in / 8-out isolated
Power Input	9-48V DC, AT/ATX, ignition power management
Operating Temp	-25°C to 70°C (45W/35W CPU)
Certifications	UL 61010-1/-2-201, CE, FCC A, UKCA, ICES-003, EMC Conformity with EN50155 & EN50121-3-2
Dimensions (WxDxH)	192 x 227 x 60.3 mm



Model	RCO-6000-RPL
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> /Core 200S Gen Intel® Core™ i3 to i9 (65W/45W/35W TDP, LGA 1700)
Chipset	Intel® R680E
Memory	2x DDR5 SODIMM, Max. 64GB
Graphics	Intel® UHD Graphics
AI Accelerator Support	Supports up to 3x Hailo-8™ AI modules
Display	2x DP 1.4a + 1x DVI-I (triple display)
Storage	2x 2.5" SATA bays (1 internal, 1 hot-swap), RAID 0/1
Expansion	1x M.2 B-Key (AI/NVMe/4G/5G), 1x M.2 E-Key, 1x Mini-PCIe
EDGEBoost I/O	2x EDGEBoost I/O Expansion
I/O Ports	2x COM (rear) + 4x COM (internal), 8x USB 3.2 Gen2 + 1x USB 3.2 Gen1 + 2x USB 2.0
LAN	2x 2.5GbE (Intel® I226, TSN)
Digital I/O	8-in / 8-out isolated
Power Input	9-48V DC, AT/ATX, ignition power management
Operating Temp	-25°C to 70°C (45W/35W CPU) -25°C to 60°C (65W CPU)
Certifications	UL 62368-1 Ed.3, CE, FCC A, UKCA, ICES-003
Dimensions (WxDxH)	240 x 261 x 79 mm

RCO-6000-RPL SERIES EDGEBOOST TECHNOLOGIES

MORE



Model	RCO-6000-RPL-2-2PWR	RCO-6000-RPL-2-4B7M	RCO-6000-RPL-4N-1E	RCO-6000-RPL-8NS
Top Nodes	RCO-6000-RPL			
EDGEBoost Node Type	GPU Expansion	Storage Expansion	GPU + Storage Expansion	Storage Expansion
Primary Function	Add-on PCIe acceleration (GPU/AI/Networking)	High-density hot-swap SATA storage	High-speed NVMe storage + AI compute	Maximum NVMe density for AI data pipelines
PCIe Expansion	1x PCIe x16 Gen4 + 1x PCIe x1 Gen3 or 1x PCIe x16 (8-lane) Gen4 + 1x PCIe x8 Gen4	-	1x PCIe x16 (GPU or RAID), + 1x PCIe x8 (open-ended)	-
Card Dimension	235 (L) x 112 (H) mm 2 Slots	-	235 (L) x 112 (H) mm 2 Slots	-
Validated GPU	NVIDIA RTX 2000 ADA, 4000 SFF ADA	-	NVIDIA RTX 2000 ADA, 4000 SFF ADA	-
Drive Bays	-	4x 7mm SATA SSD (hot-swap)	4x 7mm U.2 NVMe SSD (hot-swap)	8x 7mm U.2 NVMe SSD (hot-swap)
RAID	RAID 0/1 (via base system)	RAID 0/1/5/10	RAID 0/1/5 + optional hardware RAID 6 controller	RAID 0/1/5/10 (Software RAID only)
Additional Features	Hot-Swap Smart Fan	Hot-Swap Smart Fan, Protective Storage Bracket	Hot-Swap Smart Fan, Lockable Storage Bracket	
Power Budget	300W	-	300W	
Power Requirements	12-48V for GPU/Card expansion (4-pin terminal block)	Standard 9-48V	12-48V for NVMe/GPU Node	12-48V for NVMe Node
Operating Temp	-25°C to 60°C	-25°C to 70°C	-25°C to 45°C (with GPU)	-25°C to 60°C
Dimensions (WxDxH)	240 x 261 x 129.8 mm		240 x 261 x 166.9 mm	



# EDGEBoost TECHNOLOGIES

## EDGEBoost I/O Technology

M.2 module for 5G / NVMe / AI accelerators

## AI Accelerator

Expandable GPU or other  
PCIe 4.0 cards

## EDGEBoost I/O Technology

I/O module for M12  
/ PoE / 10GbE  
/ USB ports

## Hot-Swappable EDGEBoost Canister

High-density NVMe/SATA storage  
with RAID support

## Hot-Swappable Smart Fan

Quick maintenance & reduced downtime

## EDGEBoost Nodes Technology

Mix & Match Performance: GPU / Storage / PCIe 4.0 accelerators

Introducing our EDGEBoost Technologies – taking modular industrial solutions to new heights. The three versatile EDGEBoost Series are precisely engineered to maximize flexibility, performance, and resilience across our solution lineup. With EDGEBoost Technologies, our industrial computers become easily customizable and upgradable to meet diverse industrial demands.



Modular, Scalable  
Design



Industrial  
Ruggedness



Certification-Ready



Cost Effective



No MOQ

## EDGEBOOST I/O FOR RCO-1000 SERIES

[MORE](#)

EBIO is the perfect solution for those looking to optimize their edge infrastructure. These flexible add-on modules are a modular and scalable solution that is designed to tackle the limitations that may occur at the rugged edge. EDGEBoost I/Os are built to integrate seamlessly with our industrial computers to provide reliable expandability for mission critical I/O.

## EBIO Modules for Industrial Mini Computers

### EDGEBoost I/O Expansion

RCO-1000-10 Series	RCO-1000-20 Series	RCO-1000-30 Series
up to 1x EDGEBoost I/O support	up to 2x EDGEBoost I/O support	up to 3x EDGEBoost I/O support

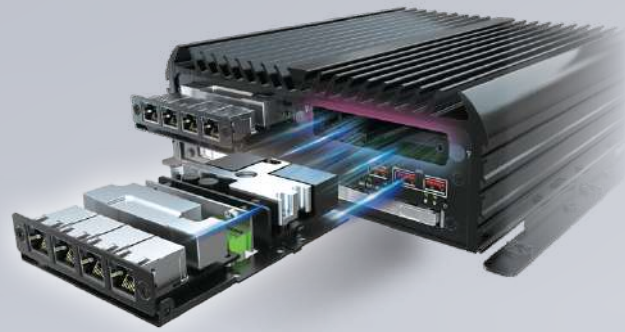


### Digital & Analog Digital and Analog EBIO Modules

EBIO-DP-DIO	EBIO-HDMI-DIO	EBIO-4USB	EBIO-2COM
up to 1x	up to 1x	up to 1x	up to 2x
<ul style="list-style-type: none"><li>1x DP (4K UHD)</li><li>1x DIO (4 in / 4 out, Isolated)</li></ul>	<ul style="list-style-type: none"><li>1x HDMI Port (Full-HD)</li><li>1x DIO (4 in / 4 out, Isolated)</li></ul>	<ul style="list-style-type: none"><li>4x USB 2.0, Type A Ports (with USB hub)</li></ul>	<ul style="list-style-type: none"><li>2x COM Ports (RS-232/422/485)</li></ul>



## EDGEBOOST I/O FOR 3000 & 6000 SERIES

[MORE](#)

### USB Interface Modules

**EBIO-4U3****EBIO-4U3-J****EBIO-4U3L-J**

- 4x USB 3.0, Type-A Ports

- 4x USB 3.2 Gen 1 (5 Gbps, 900mA)
- Type-A Locking Ports

### Connectivity & Network Modules

**EBIO-4ETH****EBIO-4ETH-J****EBIO-4ETH-M12****EBIO-4ETH-M12-J**

- 4x 1GbE LAN, RJ45 Port
- Intel® Ethernet Controller I350
- PCIe x1 Gold Fingers Interface (PCIe 3.0 x4 Performance)
- Support Power over Ethernet by an optional PoE module

- 4x 1GbE LAN, M12 Port X-code 8-Pin
- Intel® Ethernet Controller I350
- PCIe x1 Gold Fingers Interface (PCIe 3.0 x4 Performance)
- Support Power over Ethernet by an optional PoE module

**EBIO-4ETH-POE****EBIO-4ETH-POE-J****EBIO-4ETH-POE-M12****EBIO-4ETH-POE-M12-J**

- Up to 25.5 watt per port

- Complies with IEEE 802.3at

**EBIO-D10G****EBIO-D10G-J****EBIO-OOB****EBIO-OOB-J**

- 2x 10 GbE LAN, RJ45 Ports
- Intel® Ethernet Controller X710-AT2
- PCIe x1 Gold Fingers Interface (PCIe 3.0 x4 Performance)

- RJ45 Hardware-Based Features: Out-of-Band and In-Band
- Power Control & Management
- OOB Cloud Serial Console

Optional:

- Backup & Recovery
- Temper Detection
- Thermo-Guard

### Cellular, Edge AI, and Storage Modules

**EBIO-M2BK****EBIO-2M2BK****EBIO-M2MK****EBIO-M2MK-J**

- 1x M.2 B-Key 3042/3052
- Supports 4G/5G module
- 2x SIM slot, 1x SIM Switch
- 1x Dedicated Heat block
- Occupied 2x Universal Slots

- 2x M.2 B-Key 2242/3042/3052
- Supports 4G/5G/AI/NVMe modules
- 1x Mini SIM Slot (on-board)
- 1x Dedicated Heat block
- 3x Antenna Holes

- 1x M.2 M-Key 2242/2260
- Supports AI/NVMe module
- 1x Dedicated Heat block

## EDGEBOOST I/O Compatible Industrial Computers

EBIO is the perfect solution for those looking to optimize their edge infrastructure. These flexible add-on modules are a modular and scalable solution that is designed to tackle the limitations that may occur at the rugged edge. EDGEBoost I/Os are built to integrate seamlessly with our industrial computers to provide reliable expandability for mission critical I/O.



### Edge AI Industrial Computers



Super-Rugged SFF Computers



Super-Rugged Edge AI Computers



Railway &amp; In-Vehicle Computers

EBIO Modules	RCO-3000 Series	RCO-6000 Series	ACO-6000 Series
EBIO-4U3	•	•	•
EBIO-4ETH	•	•	•
EBIO-4ETH-POE	•	•	•
EBIO-4ETH-M12	•	•	•
EBIO-4ETH-POE-M12	•	•	•
EBIO-D10G	•	•	•
EBIO-OOB	•	•	•
EBIO-M2BK	•	•	•
EBIO-2M2BK	•	•	•
EBIO-M2MK	•	•	•



Jetson AI Edge Industrial Computers



EBIO Modules	JCO-6000 Series
EBIO-4U3-J	•
EBIO-4U3L-J	•
EBIO-4ETH-J	•
EBIO-4ETH-POE-J	•
EBIO-4ETH-M12-J	•
EBIO-4ETH-POE-M12-J	•
EBIO-D10G-J	•
EBIO-OOB-J	•
EBIO-M2MK-J	•

3 TYPES  
of High-Speed Camera Support

8x GMSL2      4x PoE 10x LAN      10x USB Vision



# EDGEBoost Nodes



## EDGE AI PERFORMANCE ACCELERATORS MODULES

EDGEBoost Nodes are modular add-on nodes designed for our AI Edge Inference Computer or also known as the RCO-6000 Series. These add-on nodes provide an easy and cost-effective upgrade for the rugged, fanless computer. They elevate computer performance through additional performance accelerators. The EDGEBoost Nodes deliver powerful real-time inferencing capabilities and high-speed data storage performance for intensive industrial-grade Edge AI applications.

## Customize Your Performance Accelerators



## Tested & Validated GPU List

Model Name	RAM	CUDA Cores	TDP	Display	Interface	Active Cooling	Slots
NVIDIA RTX 2000 ADA	16G	2816	70	4x mDP	PCIe 4.0 x8	Yes	2
NVIDIA RTX 4000 SFF	20G	6144	70	4x mDP	PCIe 4.0 x16	Yes	2

\* The EDGEBoost Nodes supports GPU cards with dimension of 235 mm in length, 112 mm in width, and up to 3-slot high.

\*\* The second power supply delivers stable power up to 280W for the GPU card and the NVMe drives with a wide voltage of 12-48VDC support.

# EDGEBoost Nodes

[MORE](#)

## Configuration Guide

The RCO-6000 Series is a standalone, fanless industrial computer that can be enhanced with EDGEBoost Nodes for additional performance upgrades. This two-piece modular design allows the EBND add-on nodes to seamlessly attach to the lower portion of the RCO-6000, delivering advanced performance accelerators optimized for AI edge computing.



## Configure Your Fanless Computer

Top - Compatible RCO-6000 Series			
RCO-6000-RPL		RCO-6000-CML	
	<ul style="list-style-type: none"><li>Intel® Raptor/Bartlett Lake CPU</li><li>1x Hotswap SATA SSD (7mm)</li><li>1x Internal SATA SSD (9mm)</li><li>1x M.2 B Key, 1x M.2 E Key, 1x mPCIe</li><li>2x EDGEBoost I/O Slots</li></ul>		<ul style="list-style-type: none"><li>Intel® 10<sup>th</sup> Gen CML CPU</li><li>2x Hotswap SATA SSD (7mm)</li><li>1x Internal SATA SSD (9mm)</li><li>1x M.2 E Key, 2x mPCIe</li><li>2x EDGEBoost I/O Slots</li></ul>

## Configure Your EDGEBoost Nodes

GPU / Other PCIe Cards	Bottom - Modular "EDGEboost Nodes" Configurations			
	PCI or PCIe Expansion Series		GPU Series	
Storages		<ul style="list-style-type: none"><li>EBND-2-EXP-G4 (RCO-6000-RPL) 1x PCIe x16 (Gen 4), 1x PCIe x1 (Gen 3) or 1x PCIe x16 (Gen 4), 1x PCIe x8 (Gen 4)</li><li>EBND-2-EXP (RCO-6000-CML) PCIe x16, PCI Expansions</li></ul>		<ul style="list-style-type: none"><li>EBND-2-PWR-G4 (RCO-6000-RPL) 1x PCIe x16 (Gen 4), 1x PCIe x1 (Gen 3) or 2x PCIe x8 (Gen 4)</li><li>12-48VDC Power Supply (280W)</li><li>EBND-2-PWR (RCO-6000-CML) PCIe x16, PCI Expansions 12-48VDC Power Supply (280W)</li></ul>
	SATA Storage Series			
		<ul style="list-style-type: none"><li>EBND-2-2SATA 2x Hot-Swap 2.5" SATA Drives (15mm) RAID 0, 1, 5, 10</li></ul>		<ul style="list-style-type: none"><li>EBND-2-4SATA 4x Hot-Swap 2.5" SATA Drives (7mm) RAID 0, 1, 5, 10</li></ul>
	NVMe Series			
Storages + GPU		<ul style="list-style-type: none"><li>EBND-2-2NVME-G4 (RCO-6000-RPL only) 2x Hot-Swap 2.5" NVMe SSD Bay (15mm) PCIe Gen 4 Expansion</li></ul>		<ul style="list-style-type: none"><li>EBND-8NVME-S 8x Hot-Swap 2.5" U.2 NVMe Drives (7mm) RAID 0, 1, 5, 10</li></ul>
		<ul style="list-style-type: none"><li>EBND-4NVME-S 4x Hot-Swap 2.5" U.2 NVMe Drives (15mm) RAID 0, 1, 5, 10</li></ul>		<ul style="list-style-type: none"><li>EBND-4NVME-H 4x Hot-Swap 2.5" U.2 NVMe Drives (15mm) Hardware RAID 0, 1, 5, 6, 10</li></ul>
	NVMe and GPU Series			
Storages + GPU		<ul style="list-style-type: none"><li>EBND-4NVME-GPU 1x GPU Expansion 4x Hot-Swap 2.5" U.2 NVMe Drives (7mm)</li></ul>		<ul style="list-style-type: none"><li>EBND-2NVME-GPU 1x GPU Expansion 2x Hot-Swap 2.5" U.2 NVMe Drives (15mm)</li></ul>
		<ul style="list-style-type: none"><li>EBND-4N-IE 1x PCIe x16, 1x PCIe x1 Slots Hardware RAID 0, 1, 5, 10 4x Hot-Swap 2.5" U.2 NVMe Drives (7mm)</li></ul>		



# ECO SERIES

## SUPERCAPACITOR UPS BACKUP SYSTEM



### POWER REDUNDANCY AND SAFETY AT THE RUGGED EDGE

The ECO-1000 Series EDGEBoost EnergyPack is an industrial-grade supercapacitor that provides reliable power backup, safe shutdown, and power regulation for industrial computers and HMI displays in mission-critical and remote edge deployments, ensuring uninterrupted performance during power fluctuations in unstable environments.



10-Year Lifespan



Wide Temperature, Shock, and Vibration Resistant



UL Safety & CB Scheme IEC 62368-1: 2018



EN50155 (EMC) & EN50121-3-2

## ECO-1000 EDGEBOOST ENERGYPACK [MORE](#)

- Up to 200W Max. Power Output
- 1x COM, 1x USB for GUI Remote Management and Monitoring
- Shock and Vibration Resistance (20G, 5Grms)
- 3 Smart Modes with Remote On/Off, Ignition Control, Delay Time
- 12V/24V Compatibility: Industrial PCs, Panel PCs, Displays
- Optional LCM Display Module and Button Control



Model	ECO-1000
Capacity	ECO-1000-8S: 8x 370 Farads Supercapacitors ECO-1000-16S: 16x 370 Farads Supercapacitors
Input Voltage	12 ~ 35 VDC
Input Connector	3-pin Terminal Block (V+, GND, IGN IN)
Output Voltage	Charge mode: DC IN Voltage bypass (DC OUT = DC IN) Available Discharge Mode: 12 or 24V
Output Power	ECO-1000-8S: Max.100W output ECO-1000-16S: Max.200W output
Output Connector	3-pin Terminal Block (V+, GND)
I/O	1x RS-232, 1x USB Type A, 2x DI + 2x DO with isolation Others: 1x Remote Power On/Off, 1x Smart Mode Switch, 1x Mode Reset Switch
Charging Mode	Quick and Normal Charging
Power Ignition	Power Ignition Management
Operating Temp	-25°C to 55°C
Shock & Vibration	20 G; 5 Grms
Certification	CE, FCC Class A, UL 62368-1 Ed. 3 EMC Conformity with EN50155
Dimensions (WxDxH)	100 x 192 x 192 mm
Weight	1.8 kg ~ 2.6 kg
Mounting Options	Wall Mounting, DIN Rail Mounting (Optional)



# JCO SERIES



## JETSON AI EDGE INDUSTRIAL COMPUTERS

**1000**  
Ultra  
Compact

- Jetson Orin Nano Super 4GB/8GB with 10W-25W Power Options
- Jetson Orin NX Super 8GB/16GB with 10W-40W Power Options
- 20-157 TOPS of AI Performance
- High-Speed I/O and Wireless Connectivity

**3000**  
Small Form  
Factor

- Jetson Orin Nano Super 4GB/8GB with 10W-25W Power Options
- Jetson Orin NX Super 8GB/16GB with 10W-25W Power Options
- Up to 100 TOPS of AI Performance
- Up to 3X the Performance of Jetson Xavier NX
- Optional 2x LAN or 4x PoE RJ45

**6000**  
High  
Performance

- Jetson AGX Orin 32GB/64GB with 15W-60W Power Options
- Up to 275 TOPS of AI Performance
- Up to 8X the Performance of Jetson AGX Xavier
- 2x EDGEBoost I/O Expansions

## RUGGED EDGE AI POWERED BY NVIDIA JETSON MODULES

The JCO Series industrial computer, powered by the advanced NVIDIA Jetson platform, is a standout in AI and industrial computing. This series offers exceptional AI computing capabilities, making it perfect for sophisticated robotics, autonomous machinery, and high-end embedded AI tasks. Designed to withstand harsh industrial conditions, the JCO Series ensures consistent performance even in extreme environments.



EDGEBoost I/O  
Support



Rich I/O  
Configuration



World-Class  
Certification



Ruggedized  
Fanless Solution

ENTRY-LEVEL AI EDGE COMPUTER WITH NVIDIA JETSON ORIN NANO & NX PROCESSOR

## JCO-1000-ORN SERIES [MORE](#)



Model	JCO-1000-ORN-A	JCO-1000-ORN-B	JCO-1000-ORN-C
Processor	NVIDIA® Jetson Orin™ NX Super/Nano Super		
TOPS and Memory	NX 16 GB: 1024-core NVIDIA Ampere architecture GPU (40W/157 TOPS) NX 8 GB: 1024-core NVIDIA Ampere architecture GPU (40W/117 TOPS) Nano 8 GB: 1024-core NVIDIA Ampere architecture GPU (25W/67 TOPS) Nano 4 GB: 512-core NVIDIA Ampere architecture GPU (25W/34 TOPS)		
Display Output	1x HDMI (Nano: 4K30Hz, NX: 4K60Hz)		
Storage	1x M.2 M-Key NVMe SSD (2242/2280, 128GB default) + microSD		
Expansion	1x M.2 B-Key (4G/5G), 1x M.2 E-Key (Wi-Fi/BT), 2x SIM		
LAN	1x GbE	1x GbE (RGMII), 1x 2.5 GbE (Intel® i226 IT)	1x GbE M12 (RGMII), 1x 2.5 GbE M12 (Intel® i226 IT)
Optional Feature	Out-of-Band Management	4x GMSL2 via Quad Mini Fakra Module	
I/O Ports	4x USB 3.2 Gen2, 1x USB-C (OS flash), 1x Micro-USB (console), 2x COM	1x USB 3.2 Gen2, 1x USB 2.0, 1x USB-C (OS flash), 1x Micro-USB (console), 1x COM	
DIO / CAN	4x DI + 4x DO (isolated), 1x CAN 2.0B		
Operating System	Linux Ubuntu 22.04 with Jetpack 6.2		
Power Input	9-36V DC, AT/ATX mode, ignition supported		
Operating Temp	-20°C to 55°C (15W/25W) -20°C to 35°C (40W)		
Certifications	UL 62368-1 Ed.3, CE, FCC B, UKCA, ICES-003	UL 62368-1 Ed.3, E-Mark, EN50155 EMC, CE, FCC B, UKCA, ICES-003	
Dimensions (WxDxH)	150 x 105 x 65 mm		
Weight	1.1 kg		



JCO-3000-ORN

SERIES

MORE



Model	JCO-3000-ORN-B
Processor	NVIDIA® Jetson Orin™ NX / Nano Super
TOPS and Memory	NX 16 GB: 1024-core NVIDIA Ampere architecture GPU (25W/100 TOPS) NX 8 GB: 1024-core NVIDIA Ampere architecture GPU (25W/70 TOPS) Nano 8 GB: 1024-core NVIDIA Ampere architecture GPU (25W/67 TOPS) Nano 4 GB: 512-core NVIDIA Ampere architecture GPU (25W/34 TOPS)
Display Output	1x HDMI (Nano: 4K30Hz, NX: 4K60Hz)
Storage	1x M.2 M-Key NVMe SSD (2242/2280, default 128GB) + microSD
Expansion	1x M.2 B-Key (4G/5G), 1x M.2 E-Key (Wi-Fi/BT), 1x Dual SIM
LAN	4x GbE RJ45 (RGMII, Intel® I226), optional 4x PoE+ (120W total, Max. 25W/port)
Optional Feature	Out-of-Band Management (1x RJ45)
I/O Ports	4x USB 3.2 Gen2, 1x USB-C (OS flash), 1x Micro-USB (console), 2x COM (RS-232/422/485), 1x CAN 2.0B
DIO / CAN	8x DI + 8x DO (isolated), 1x CAN 2.0B
Operating System	Linux Ubuntu 22.04 with JetPack 6.2
Power Input	9–36V DC, AT/ATX mode, ignition supported
Operating Temp	-20°C to 60°C (15W mode) -20°C to 55°C (25W mode)
Certifications	UL 62368-1 Ed.3, E-Mark, EN50155 EMC, CE, FCC B, UKCA, ICES-003
Dimensions (WxDxH)	192 x 140 x 58 mm
Weight	2.8 ~ 3.6 kg

JCO-6000-ORN

SERIES

MORE



Model	JCO-6000-ORN-A
Processor	NVIDIA® Jetson AGX Orin™ — 12-core (64GB, 60W, 275 TOPS) or 8-core (32GB, 40W, 200 TOPS)
TOPS and Memory	AGX 64 GB: 2048-core NVIDIA Ampere GPU, 12-core ARM Arm® Cortex® (275 TOPS) AGX 32 GB: 1792-core NVIDIA Ampere GPU, 8-core ARM Arm® Cortex® (200 TOPS)
Display Output	1x HDMI (3840 x 2160 @ 60Hz)
Storage	1x eMMC 5.1 (64GB), 1x M.2 M-Key NVMe SSD (2280, PCIe x4, 128GB default) + microSD
Expansion	1x M.2 B-Key (4G/5G), 1x M.2 E-Key (Wi-Fi/BT), 2x SIM
EDGEBoost I/O	2x EDGEBoost I/O Brackets supporting: LAN, PoE, M12, 10 GbE, USB 3.0 Locking and NVMe M.2 SSD
LAN	1x 1GbE (Marvell 88E1512), 1x 10GbE (Marvell AQC113)
Camera Support	Optional GMSL2 (2x Quad Mini-Fakra) supporting 8x Cameras @ 1280x720 @ 30FPS
I/O Ports	1x USB 3.2 Gen2, 1x USB 2.0 (OS Flash), 1x USB-C (Console), 2x COM (RS-232/422/485), 2x CAN 2.0B
DIO / CAN	8x DI + 8x DO (isolated), 2x CAN 2.0B
Operating System	Linux Ubuntu 22.04 with JetPack 6.2
Power Input	9-48V DC, AT/ATX mode, adjustable ignition sensing
Operating Temp	-20°C to 55°C (AGX 64GB MaxN, non-throttle) -20°C to 50°C (AGX 64GB with PoE/10G/USB modules, full CPU+GPU load)
Certifications	UL 62368-1 Ed.3, E-Mark, EN50155 EMC, CE, FCC B, UKCA, ICES-003
Dimensions (WxDxH)	270 x 190 x 95 mm
Weight	6 ~ 7 kg



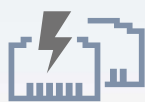
# ACO SERIES



## RAILWAY & IN-VEHICLE INDUSTRIAL COMPUTERS

### DELIVER INTELLIGENCE AT THE MOBILE EDGE

The ACO-6000 Series offers robust, fanless in-vehicle computers, rigorously tested for mission-critical automotive applications. Essential for intelligent transportation, these systems adeptly handle edge data processing for machine learning and intelligence. With the need for high-performance computing in vehicles, they efficiently process data from various sensors and IoT devices, ensuring swift, low-latency communication.



Scalable  
16x PoE



EN50155 / EN45545  
and E-Mark





Wide Power Range  
9~48V and 48~110V



MIL-STD-810H  
Compliant  
Method 514 & 517


HIGH-PERFORMANCE RAILWAY & IN-VEHICLE FANLESS COMPUTER

## ACO-6000-CML SERIES [MORE](#)

<div><div>intel</div><div></div></div>		
Model	ACO-6000-CML	ACO-6000-CML-1
Processor	10 <sup>th</sup> Gen Intel® Core™ i3 to i9 (65W/35W TDP, LGA 1200), Intel® XEON-W Processors	
Memory	2x DDR4 SODIMM, Max. 64GB	
Display Output	2x DP + 1x DVI-I (Triple Display)	
Storage	1x Internal + 2x Hot-swap 2.5" SATA (RAID 0/1/5)	
Expansion	1x M.2 E-Key, 2x Full-size Mini-PCIe, 2x EDGEBoost I/O slots	1x M.2 E-Key, 2x Full-size Mini-PCIe, 4x EDGEBoost I/O slots, 1x PCIe x16
LAN Options	2x GbE	2x GbE + Optional 16x GbE (RJ45/M12; LAN/PoE)
Power Input	9~48VDC; 48~110VDC (Optional)	
Operating Temperature	-25°C to 70°C (35W CPU)	
Certifications	EN50155 / EN50121-3-2 Railway EMC, E-Mark, CE, FCC A, UKCA, ICES-003	
Dimensions (WxDxH)	240 x 261 x 79.2 mm	240 x 261 x 127.3 mm




ACO-6000-RPL



Model	ACO-6000-RPL
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i3 to i9 (65W/35W TDP, LGA 1700)
Memory	2x DDR5 SODIMM, Max. 64GB (ECC / Non-ECC)
Display Output	Triple Display: 2x DisplayPort + 1x DVI-I
Storage	3x 2.5" SATA bays (1 internal + 2 hot-swap), RAID 0/1
Expansion	1x M.2 B-Key (AI/Storage/4G/5G), 1x M.2 E-Key (Wi-Fi/BT), 1x Full-size Mini-PCle, 2x EDGEBoost I/O Slot
LAN Options	2x 2.5GbE LAN, 4x USB 3.2 Gen2, 2x USB 2.0, 2x COM, 8x DI + 8x DO (isolated), 1x CAN 2.0B
Power Input	9-48V DC input, AT/ATX mode, Ignition Power Management
Operating Temperature	-25°C to 70°C (35W CPU) -25°C to 60°C (65W CPU)
Certifications	EN50155 / EN50121-3-2 Railway EMC, UL 62368-1 Ed.3, CE, FCC A, UKCA, ICES-003
Dimensions (WxDxH)	240 x 261 x 79.1 mm

ACO-3000-ORN SERIES



Model	ACO-3000-ORN-4L-IP66
Processor	NVIDIA® Jetson Orin™ NX Super/Nano Super
TOPS and Memory	NX 16 GB: 1024-core NVIDIA Ampere architecture GPU (40W/157 TOPS) NX 8 GB: 1024-core NVIDIA Ampere architecture GPU (40W/117 TOPS) Nano 8 GB: 1024-core NVIDIA Ampere architecture GPU (25W/67 TOPS) Nano 4 GB: 512-core NVIDIA Ampere architecture GPU (25W/34 TOPS)
Storage	M.2 M-Key NVMe SSD (128GB default) and 1x MicroSD 3.0 slot.
Expansion	1x M.2 E-Key (Wi-Fi), 1x M.2 B-Key (4G/5G), and 1x M.2 B-Key (PCIe x1 + USB2.0, 2242/2280).
LAN	4x 2.5GbE (M12 X-coded, waterproof rugged connectors).
USB & Console	USB 3.2 Gen2 Type-A, USB 2.0 Type-A, USB-C (OS Flash), Micro-USB (Console).
Serial & Camera	2x COM RS-232/422/485 (M12 A-coded) and 4x GMSL2 Fakra-Z camera ports (optional).
DIO / CAN / Audio	4x DI / 4x DO (Isolated), CAN 2.0B (M12 A-coded), Mic-in + Line-out (M12 A-coded).
PoE	Optional 4-port 60W PoE module supporting IEEE 802.3af (4 ports) and 802.3at (2 ports).
Operating System	Ubuntu 22.04 with NVIDIA JetPack 6.2.
Power Input	9-48V DC via M12 K-code connector, AT/ATX mode, ignition sensing, OVP/OCP/Reverse Protection.
Operating Temperature	-20°C to 50°C (40W mode) and -20°C to 60°C (25W/15W power modes).
Certifications & Protection	IP66 Waterproof; CE, FCC Class B, ICES-003, UKCA; Railway EMC: EN50155; E-Mark (E24); UL 62368-1 Ed.3

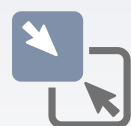
# DCO SERIES



## DIN RAIL FANLESS INDUSTRIAL COMPUTERS

### COMPACT & RICH I/O CONFIGURATION FOR DIN RAIL APPLICATIONS

The DCO-1000-ASL is a compact, fanless DIN-rail industrial computer designed for demanding IoT environments. Built to operate reliably in extreme temperatures and resist shock and vibration, it's ideal for space-constrained industrial applications requiring advanced remote management and top-tier durability.



Compact  
Form Factor



Rich I/O  
Configuration



Industrial IoT  
Solutions



Ruggedized  
Fanless Solution

## DIN RAIL FANLESS INDUSTRIAL COMPUTER

### DCO-1000-ASL

[MORE](#)

Designed for flexibility, the DCO-1000-ASL features a comprehensive I/O suite and multiple M.2 expansion slots, enhancing connectivity and customization for industrial applications. Perfect for demanding environments, it provides advanced remote management and robust certifications, ensuring reliable performance in automation and smart city infrastructure.



intel ai

Model	DCO-1000-ASL
Processor	Intel® Atom® x7433RE (Quad-Core, 3.4GHz Turbo, 9W TDP) Intel® Atom® x7835RE (8-Core, 3.6GHz Turbo, 12W TDP)
Memory	1x DDR5 4800MHz SODIMM, Max. 16GB (In-Band ECC supported)
Display Output	2x DisplayPort 1.4 (4096x2160 @ 60Hz), Dual Independent Display
Storage	1x M.2 B-Key (PCIe x2 NVMe, 2242)
Expansion	1x M.2 B-Key (4G/5G module), 1x M.2 E-Key (Wi-Fi/BT), Dual SIM
I/O Ports	4x 2.5GbE LAN (Intel® I226), 2x COM (RS-232/422/485), 2x USB 3.2 Gen2, 2x USB 2.0, 4x DI + 4x DO (isolated)
Optional Feature	Out-of-Band Management (RJ45), CAN Bus x2 (internal header)
Power Input	9-36V DC, 3-pin terminal block, AT/ATX mode, OVP/OCP/Reverse Protection
Operating Temp	-40°C to 65°C
Operating System	Windows 10 / Windows 11, Linux Kernel 6.2
Certification	UL 61010-1, UL 61010-2-201, CE, FCC Class A, UKCA, ICES-003, RoHS3, REACH
Shock & Vibration	Shock: 20G, 11ms; Vibration: 5 Grms (5-500Hz) DIN-Rail / Wall-Mount
Dimensions (WxDxH)	150 x 105 x 50 mm
Weight	0.85 kg



# WCO SERIES



## IP68/IP69K WATERPROOF INDUSTRIAL COMPUTERS

### DELIVER EDGE INTELLIGENCE AMID WATER AND DUST EXPOSURES

The WCO Series unifies advanced CPU compute capabilities, I/O expandability, and AI acceleration for dynamic industrial deployments. The WCO Series is designed to fit into a rugged industrial environment where dust and water resistance are a must. Equipped with fanless design and IP68/IP69K ratings, the WCO series expands the limitation of regular embedded systems in extremely harsh deployments.



IP68/IP69K  
Rating



Wide Range Voltage  
9-36V or 48-110V



Scalable M12  
Ports



High-Quality  
Compact Construction

IP68/IP69K WATERPROOF COMPUTER

## WCO-3000-EHL

[MORE](#)

intel.



Model	WCO-3000-EHL
Processor	Intel® Atom® x6425E (Quad-Core, 2.0 GHz, 12W TDP)
Memory	1x DDR4 SODIMM, Max. 32GB
Display Output	1x DisplayPort 1.4 (4096x2160 @ 60Hz) or optional HDMI
Storage	1x Internal 2.5" SATA drive bay + 1x mSATA (shared with Mini-PCIe)
Expansion	1x M.2 B-Key (3042/3052, PCIe x1 + USB 3.2), 1x Mini PCIe, 2x Internal SIM
I/O & LAN	2x LAN (M12 X-Code: 1x 1GbE + 1x 2.5GbE), 1x RS-232/422/485 (M12 A-Code), 2x USB 3.2 Gen2 (M12), 2x CAN Bus (internal header), Audio (Mic-in / Line-out)
Optional Features	HDMI, 2x PoE, AI Hailo/5G, Ignition Power Control
Power Input	9-36V DC (M12 S-Code), optional 48-110V DC; AT/ATX mode; OVP/OCP/Reverse Protection
Operating Temperature	-40°C to 60°C (per IEC60068-2-1/2/3/14 environmental tests)
Operating System	Windows 10, Linux Kernel 5.x
IP Rating	IP68 / IP69K waterproof & dustproof (sealed M12 I/O, fully enclosed chassis)
Certifications	CE, FCC Class A, ICES-003, UKCA, IEC60068-2-27 shock, IEC60068-2-64 vibration, MIL-STD-810H compliant
Mechanical Design	Extruded aluminum + heavy-duty metal; M12 rustproof I/O; wall-mount
Dimensions (WxDxH)	231 x 292 x 57 mm

IP68: A rating standard for dust and water resistance

- 6: Dust-tight, meaning no dust ingress. Full protection against dust.
- 8: Withstand continuous immersion in water (typically up to 1 meter or more)

IP69K: Specifically tested for high-pressure, high-temperature water jets.

- 6: Dust-tight, providing complete protection against dust ingress. (Same as IP68)
- 9K: Withstand high-temperature water jets (water temperatures up to 80°C) & High-pressure water jets (pressure up to 100 bar (1450 psi))

# VCO SERIES



## MACHINE VISION INDUSTRIAL COMPUTERS

### PCIe CARD EXPANSION FOR INTELLIGENT COMPUTER VISION

The VCO-6000 Series is engineered for seamless integration of dual FHFL GPU cards through PCIe Gen 4 and industry-leading external storage expansion drives, delivering optimized processing and data aggregation. Deploy machine vision and AI inference applications with utmost reliability and performance to the rugged edge.



Dual GPU Support  
(FHFL)



PCIe Gen 4  
Performance



Scalable NVMe &  
SATA Storage



Shock & Vibration  
Resistance

## VCO-6000-RPL SERIES [MORE](#)



Model	VCO-6000-RPL-3-2PWR	VCO-6000-RPL-4-2PWR
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> /Core 200S Gen Intel® Core™ i3 to i9 (65W/45W/35W TDP, LGA1700)	
Chipset	Intel® R680E	
Memory	2x DDR5 SODIMM, Max. 64GB (ECC / Non-ECC)	
Display Output	2x DP 1.4a + 1x DVI-I (Triple Display)	
Storage	1x Internal 2.5" SATA + 1x Removable 2.5" SATA (RAID 0/1) Optional 2x/4x Hot-Swap 2.5" SATA/NVMe (RAID 0/1/5/10)	
Expansion	1x M.2 B-Key (NVMe / AI / 4G/5G), 1x M.2 E-Key, 1x Mini-PCIe, Dual SIM	
I/O Ports	2x 2.5GbE LAN (Intel® I226, TSN), 4x USB 3.2 Gen2, 2x USB 3.2 Gen1 (internal), 6x COM (4 internal), 8x DI + 8x DO, Universal I/O bracket	
PCIe Expansion	1x PCIe x16 (Gen4) 2x PCIe x4 (1-Lane, Gen2)	2x PCIe x16 Slot (8-lane, Gen 4) 1x PCIe x4 (1-lane, Gen 3)
Card Dimension	310 (L) x 112 (H) mm, 3-Slot	310 (L) x 112 (H) mm, 4-Slot
GPU Power	600W power budget via dedicated 48V GPU power rail	
Validate GPU	NVIDIA RTX 2000 ADA, 4000 SFF ADA, 4000 ADA, 4500 ADA, 5000 ADA	Support Dual GPU
Power Input	9-48V DC + 48V GPU power rail, AT/ATX, Ignition Control, OVP/OCP/Reverse Protection	
Operating Temperature	-25°C to 70°C (35W CPU) -25°C to 60°C (65W CPU)	
Certifications	UL 62368-1 Ed. 3, CE, FCC A, UKCA, ICES-003, MIL-STD-810H Compliant	
Dimensions (WxDxH)	157 x 340 x 240 mm	177 x 340 x 240 mm



# KCO SERIES



## FANNED INDUSTRIAL COMPUTERS

### ACTIVE COOLING INDUSTRIAL COMPUTER FOR INSPECTION & INTELLIGENT COMPUTER VISION

Introducing the KCO-RPL Series, a line of high-performance fanned industrial computers powered by Intel® 13<sup>th</sup> Gen Raptor Lake processor. These ruggedized edge computers deliver extensive scalability and IIoT-centric flexibility for seamless optimization in high-spec deployment applications. Additionally, the KCO-RPL Series provides a number of edge-native features to accommodate and ensure reliable performance at the rugged edge.



Support Dual GPU



Rich M.2 and PCIe Expansions



Internal Flex Power Supply



Rackmountable Industrial Solution

HIGH-PERFORMANCE FANNED INDUSTRIAL COMPUTER

## KCO-2000-RPL [MORE](#)



Model	KCO-2000-RPL
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i3 to i9 (65W, LGA1700)
Chipset	Intel® Q670E
Memory	4x DDR4 DIMM, Max. 128GB
Display Output	4x DP++
Storage	1x Hot-swap 2.5" SSD (7mm), 4x SATA III
M.2 Expansion	2x M-Key (NVMe Gen4), 1x E-Key
I/O & LAN	1x 2.5GbE + 1x 1GbE, USB-C Gen2x2, 6x USB 3.1 Gen2, 4x USB 2.0, 2x COM + 4x internal COM, Audio
PCIe Expansion	1x PCIe x16 Gen5, 1x PCIe x16 Gen4 (x4 electrical), 1x PCIe x4 Gen4 (open-end), 1x PCIe x4 Gen3 (open-end)
PCIe Slots	4x slots, low-profile
Validated GPU	NVIDIA 2000 ADA / 4000 SFF ADA
Power Input	250W Flex PSU (AC 100-240V)
Operating Temperature	0°C to 40°C
Certifications	UL 62368-1 Ed. 3, CE, FCC, ICES-003, UKCA
Form Factor	2U Short-Depth
Dimensions (WxDxH)	324 x 276 x 89 mm

KCO SERIES

KCO-3000-RPL

MORE



Model	KCO-3000-RPL
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i3 to i9 (65W, LGA1700)
Chipset	Intel® Q670E
Memory	4x DDR4 DIMM, Max. 128GB
Display Output	4x DP++
Storage	1x 3.5" HDD or 2x 2.5" SSD/HDD (15mm), 4x SATA III
M.2 Expansion	2x M-Key (NVMe Gen4), 1x E-Key
I/O & LAN	1x 2.5GbE + 1x 1GbE, USB-C Gen2x2, 6x USB 3.1 Gen2, 4x USB 2.0, 2x COM + 4x internal COM, Audio
PCIe Expansion	1x PCIe x16 Gen5, 1x PCIe x16 Gen4 (4-Lane), 1x PCIe x4 Gen4 (open-end), 1x PCIe x4 Gen3 (open-end)
PCIe Slots	4x slots
Validated GPU	NVIDIA RTX 2000 ADA, 4000 SFF ADA, 4000 ADA, 4500 ADA, 5000 ADA
Power Input	500W Flex PSU (AC 100-240V)
Operating Temperature	0°C to 50°C
Certifications	UL 62368-1 Ed. 3, CE, FCC, ICES-003, UKCA
Form Factor	3U Rackmount
Dimensions (WxDxH)	324 x 300 x 133 mm

KCO-6000-ARL



Coming Soon

Model	KCO-6000-ARL
Processor	Intel® Core™ Ultra 9/7/5 (65W TDP, LGA1851)
Chipset	Intel® W880
Memory	2x DDR5 5200MHz SODIMM, Max. (Non-ECC)
Display Output	2x DP, 1x HDMI (Triple Display)
Storage	1x M.2 M-Key (PCIe x4 NVMe / SATA), 1x 2.5" SATA bay
Expansion	1x M.2 E-Key (Wi-Fi), 1x M.2 B-Key (PCIe x2 NVMe/USB3.2, SIM holder)
I/O & LAN	3x 2.5GbE LAN, 6x USB 3.2 Gen2, 6x COM, Line-out + Mic-in, GPIO
PCIe Expansion	4x PCIe Slots, PCIe x16 Gen5 and Gen4
Supported GPU	Full-Length, Full-Height Blackwell GPUs
Power Input	DC-IN, AT/ATX mode (default ATX), 4-pin terminal block, OVP/OCP/Reverse Protection
Operating Temperature	-10°C to 50°C
Certifications	UL 62368-3, CE, FCC A, ICES-003, UKCA
Mounting Options	Wall Mount



# LLM SERIES



## 1U EDGE AI RACKMOUNTABLE SERVER

### SCALE GEN AI AT THE EDGE

The LLM-1U-RPL Series is a high-performance, short-depth 1U edge AI server engineered for on-premises multimodal deployment in industrial environments. It delivers low latency inferencing to enable real-time genAI and LLM workloads by processing the sensor data at the source of data generation.



Real-Time  
Performance



Gen AI  
Inferencing



Operational  
Redundancy



Robust Physical  
Security

### 1U EDGE AI RACKMOUNTABLE SERVER

## LLM-1U-RPL [MORE](#)



Model	LLM-1U-RPL
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i3 to i9 (65W/35W TDP, LGA 1700)
Chipset	Intel® Q670E
Memory	2x DDR4 3200 SODIMM, Max. 64GB
Display Output	Triple Display: 2x DP 1.4a + 1x HDMI 1.4b
Storage	2x 2.5" Hot-swap SATA SSD bays (7mm/15mm), RAID 0/1 supported
M.2 Expansion	1x M-Key (PCIe Gen3 x4 NVMe), 1x B-Key (NVMe/AI/4G/5G), 1x E-Key (Wi-Fi/BT)
I/O Ports	3x 2.5GbE LAN, 6x USB 3.2 Gen2 (Rear), 2x USB 3.2 Gen1 (Front), 2x COM
PCIe Slot	1x PCIe x16 Gen4 or 2x PCIe x8 Gen4
Card Dimension	267 (L) x 112 (H) mm, dual-slot GPU
Validated GPU	NVIDIA RTX 2000 ADA, 4000 SFF ADA, 4000 ADA, 4500 ADA, 5000 ADA
Power Input	Dual 600W Redundant PSU (AC 115-230V or DC -36 to -72V), AT/ATX mode, ignition supported
Operating Temperature	0°C to 35°C (with 0.6 m/s airflow)
Certifications	UL 62368-1 Ed. 3, CE, FCC Class A, ICES-003, UKCA
Mounting Options	Standard 1U rackmount (19-inch rack compatible)
Dimensions (WxDxH)	483 x 480 x 44 mm



## BUILT RUGGED. BUILT READY.



## INDUSTRIAL DISPLAY SYSTEMS



**FIO** SERIES

**IP65 OPEN FRAME**  
INDUSTRIAL  
TOUCHSCREEN  
MONITORS



**HIO** SERIES

**IP65 OPEN FRAME**  
INDUSTRIAL  
TOUCHSCREEN  
COMPUTERS



**AIO** SERIES

**IP65 ALL-IN-ONE**  
INDUSTRIAL  
TOUCHSCREEN  
COMPUTERS



**VIO** SERIES

**IP65 MODULAR**  
**SYSTEMS**  
HIGH-BRIGHTNESS  
DISPLAY



**SIO** SERIES

**IP66/69K**  
**STAINLESS STEEL**  
INDUSTRIAL  
TOUCHSCREEN  
COMPUTERS

### PC SERIES

**VIO COMPUTER**  
**MODULES**  
PC MODULE FOR  
INDUSTRIAL  
DISPLAY

### MX SERIES

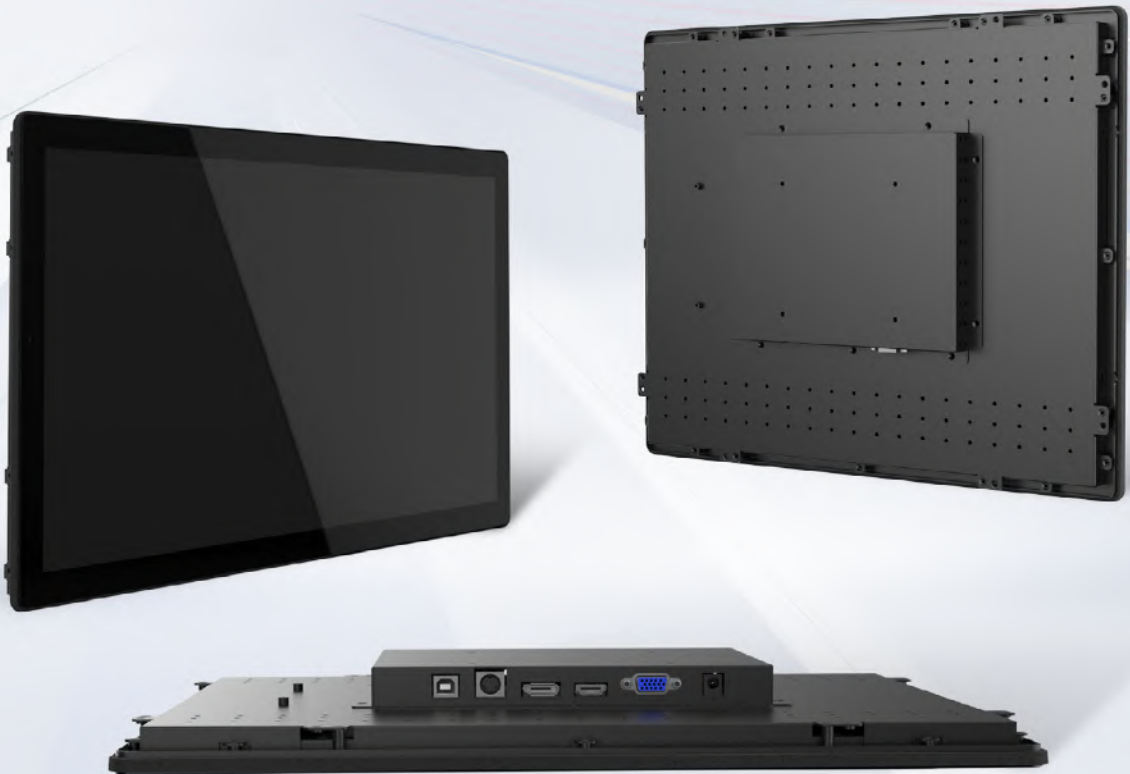
**VIO MONITOR**  
**MODULES**  
MONITOR MODULE  
FOR INDUSTRIAL  
DISPLAY

Model	SIO SERIES	VIO SERIES	AIO SERIES	HIO SERIES	FIO SERIES
Ruggedness	Super-Rugged	Rugged	Semi-Rugged	Durable	
System Configuration	Touchscreen Computer	Touchscreen Computer or Monitor	Touchscreen Computer or Monitor	Touchscreen Computer	Touchscreen Monitor
Processor	<ul style="list-style-type: none"><li>Intel® Alder Lake N97</li><li>Intel® Celeron® J1900</li><li>Intel® 8<sup>th</sup> Gen i5</li></ul>	<ul style="list-style-type: none"><li>Intel® Core™ Ultra 5/7</li><li>Intel® 7<sup>th</sup> Gen i3/i5</li><li>Intel® Celeron® J6413</li><li>Intel® Celeron® J1900</li></ul>	<ul style="list-style-type: none"><li>Intel® Core™ Ultra 5/7</li><li>Intel® Alder Lake N97</li><li>Intel Atom® X7835RE</li><li>Rockchip RK3568J</li></ul>	<ul style="list-style-type: none"><li>Intel® Alder Lake N97</li></ul>	-
Wireless Connectivity	Wi-Fi 6E, BT 5.x, 5G/4G/LTE			Wi-Fi 6E, BT 5.x	-
IP Rating	Full IP66/69K	Front IP65			
Built Design	Rugged Stainless-Steel SUS 316 Design	Modular Flexible Design	All In One Simple Design	Industrial Open Frame Design	
Screen Sizes	15" - 23.8"	12.1" - 23.8"	10.1" - 21.5"		15" - 27"
Touch Options	PCAP	PCAP/Resistive	PCAP		
Optical Bonding	Standard	Optional	-	-	-
Mounting Options	VESA Mount Yoke Mount	VESA Mount Panel Mount		Open-Frame Wall Mount	Open-Frame VESA Mount Panel Mount
Shock & Vibration	20G & 2.4Grms	20G & 1.5Grms	20G & 3Grms MIL-STD-810H Method 516.7 & 514.7 Procedure 1		-
Certifications	CE, FCC	CE, FCC, UL		CE, FCC	CE, FCC, UL

Our industrial touchscreen computers and monitors offer tailored solutions for diverse needs, featuring modular designs, stainless steel washdown panels, and open-frame PCs—built to tackle application challenges with precision and reliability.



# FIO SERIES



## INDUSTRIAL OPEN-FRAME TOUCHSCREEN MONITORS

### INDUSTRIAL HMI TOUCHSCREENS

The FIO Series are selection of standardized industrial open-frame touchscreen monitors that are designed to seamlessly integrate into both future and existing HMI systems. With the slim industrial-grade design, extended lifespan and world-class certifications, the FIO Series are purpose-built for ruggedized and suitable for various industries required minimal to no maintenance.



10-Points  
PCAP Touch



Front Panel  
IP65



50,000+  
Hours MTBF



World Class Certifications  
(UL, CE, FCC)

### INDUSTRIAL OPEN-FRAME TOUCHSCREEN MONITORS

#### FIO SERIES [MORE](#)

HMIs (Human-Machine Interfaces) are critical data points for real-time controls, status, and information. Premio's line of rugged open-frame touchscreen monitors, FIO Series, are purpose-built to deliver dedicated data visualization and controls for industrial deployment applications. Designed for flexible compatibility, the FIO Series follows a standardized approach for seamless integration into both existing and future systems.

Open Frame



Model	FIO-XG1500C	FIO-SX1900C	FIO-FH2150C	FIO-FH2700C
LCD Size	15" (4:3)	19" (5:4)	21.5" (16:9)	27" (16:9)
Max. Resolution	1024 x 768 @60Hz	1280 x 1024 @60Hz	1920 x 1080 @60Hz	
Brightness (cd/m2)	350 nits	250 nits		300nits
Contrast Ratio	1000:1		3000:1	
LCD Color	16.7M			
Viewing Angle (H-V)	176/176	178/178		
Internal Speaker	AMP 5W + 5W	AMP 10W + 10W		
Touch Type	Projected Capacitive (PCAP) Touch, Multi-Touch up to 10 points			
I/O	1x Mini Din (External OSD) 1x USB (Type B) 1x DP 1x HDMI 1x VGA			
Power	12 VDC 100-240V AC, 50-60Hz			
Operating Temperature	0°C to 40°C		0°C to 50°C	0°C to 40°C
Certification	FCC, CE, UL 62368-1 3rd Ed			
Mounting Options	VESA: 75x75mm, 100x100 mm Rear Mounting, Side Mounting		VESA: 100x100 mm Rear Mounting, Side Mounting	VESA: 100x100 mm, 100x200 mm Rear Mounting, Side Mounting
Dimensions (WxHxD)	358 x 284.9 x 40.3 mm	420.1 x 348.1 x 42.1 mm	516 x 311 x 37.9 mm	644.2 x 388.4 x 40.8 mm
Weights (Net)	3.52 kg	4.82 kg	5.56 kg	7.35 kg

\* The FIO Series is available exclusively for the North Americas, contact sales@premioinc.com for more information.

# HIO SERIES



## IP65 OPEN-FRAME INDUSTRIAL TOUCHSCREEN COMPUTERS

### OEM INTEGRATION READY FOR HUMAN MACHINE INTERFACE SOLUTIONS

The HIO Series is a versatile panel PC solution that unifies high efficient computing capabilities with I/O expandability. Designed for seamless industrial and commercial application integration with its sleek open frame design and advanced functionality.



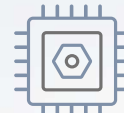
10-Points  
PCAP Touch



Diverse I/O  
Customization



Front Panel  
IP65







High Computing  
Efficiency

## IP65 OPEN FRAME TOUCHSCREEN COMPUTER

### HIO-200-ADL SERIES [MORE](#)

HIO Series provides a selection of Open Frame Touchscreen Computers ranging from 10.1" to 21.5" for seamless integration for HMI deployments. With ultimate screen readability and clarity, this series is front panel IP65 rated with 7H scratch resistant. All while being powered by Intel® Alder Lake N97 processor.

<div></div>			
Model	HIO-W210-ADL	HIO-W215-ADL	HIO-W221-ADL
Display Size & Resolution	10.1" 1280 x 800 (WXGA)	15.6" 1920 x 1080 (FHD)	21.5" 1920 x 1080 (FHD)
Brightness	400 nits	400 nits	500 nits
Touchscreen	10-Point PCAP, 7H hardness		
Processor	Intel® Processor N97, up to 3.6GHz		
Memory & Storage	8GB DDR5 (max 16GB) + 128GB M.2 B-Key SSD		
I/O & LAN	4x USB 3.2 Gen2, 4x USB 2.0 (internal), 2x 2.5GbE LAN, 2x COM, Line-out		
Display Output	1x DP (4K@60), 1x HDMI (UHD@30)		
Expansion	1x M.2 E-Key (Wi-Fi 6E optional), dual PIFA antenna support		
Power Input	9-36V DC (60W adapter default)		
Operating Temperature	-10°C to 50°C		
Mounting Options	Open-frame panel mount, wall mount		
Dimensions (WxHxD)	252 x 166 x 39 mm	395 x 245 x 40 mm	533 x 325 x 46 mm



# AIO SERIES



IP65  
DISPLAY

INDUSTRIAL TOUCHSCREEN  
MONITORS

- AIO-200-MX Series

IP65  
ALL-IN-ONE

INDUSTRIAL TOUCHSCREEN  
COMPUTERS

- AIO-200-ROK Series
- AIO-200-ADL Series
- AIO-200-MTL Series

## IP65 ALL-IN-ONE INDUSTRIAL TOUCHSCREEN COMPUTERS

### SIMPLE SOLUTION FOR HUMAN MACHINE INTERFACE DEPLOYMENTS

The AIO Series is a reliable all in one panel PC solution that simplifies HMI solutions with high efficient computing capabilities and advanced I/O connectivity. Designed for simple industrial and commercial applications with its sleek all in one panel design and comprehensive functionality.



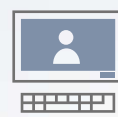
All In One Integrated  
System



10-Point PCAP  
Touch



Range of Display  
Size



Triple Independent  
Displays

INDUSTRIAL TOUCHSCREEN MONITORS BUILT FOR RELIABILITY AND CONTROL

## AIO-200-MX SERIES [MORE](#)


The AIO-200-MX Series offers a range of rugged touchscreen monitors engineered for industrial automation, factory HMI, and control room operations. Available in 10.1", 15.6", and 21.5" sizes, these fanless, cableless, and glove-friendly displays deliver exceptional durability and seamless performance—even in the most demanding conditions.




Model	AIO-W210-MX	AIO-W215-MX	AIO-W221-MX
Display Size & Resolution	10.1” 1280 x 800 (WXGA)	15.6” 1920 x 1080 (FHD)	21.5” 1920 x 1080 (FHD)
Brightness	400 nits	450 nits	400 nits
Touchscreen	PCAP, 10-point, 7H / IK07		
Front IP Rating	IP65		
I/O Ports	1x DP 1.1, 1x HDMI 1.4a, 2x USB 2.0, 1x USB Type-B (touch), Audio out, Speakers		
Power Input	12-24V DC (60W adapter included)		
Operating Temperature	-10°C to 50°C	0°C to 50°C	
MTBF	30,000 hours	50,000 hours	
Mounting Options	VESA 75/100, Panel Mount (optional)		
Dimensions (WxHxD)	256 x 170 x 50 mm	400 x 249 x 50 mm	538 x 329 x 62 mm


## AIO-200-ROK SERIES

MORE





NEW





NEW


Model	AIO-W210-RK3568J	AIO-W215-RK3568J
Display Size & Resolution	10.1" 1280 x 800 (WXGA)	15.6" 1920 x 1080 (FHD)
Brightness	500 nits	
Touchscreen	PCAP, 7H / IK07 hardness	
IP Rating	IP65 (front bezel)	
Processor	Rockchip RK3568J Quad Cortex-A55, up to 2.0 GHz	
Memory & Storage	4GB LPDDR4 + 64GB eMMC	
I/O Ports	2x USB 3.0, 2x COM, 2x GbE LAN, 1x CAN, Line-out	
Expansion	1x M.2 E-Key (Wi-Fi 6), 1x M.2 B-Key (4G/LTE), antenna support	
Operating System	Android 13, Debian 11, Ubuntu 22.04	
Power Input	12-24V DC, 60W AC adapter	
Operating Temperature	-20°C to 60°C	
Mounting Options	VESA 75/100, Panel Mount (optional)	


## AIO-200-ADL SERIES

MORE











Model	AIO-W210-ADL	AIO-W215-ADL	AIO-W221-ADL
Display Size & Resolution	10.1" 1280 x 800 (WXGA)	15.6" 1920 x 1080 (FHD)	21.5" 1920 x 1080 (FHD)
Brightness	400 nits	400 nits	500 nits
Touchscreen	PCAP, 7H / IK07 hardness		
IP Rating	IP65 (front bezel)		
Processor	Intel® Processor N97, up to 3.6 GHz		
Memory & Storage	DDR5 up to 16GB + 128GB M.2 B-Key SSD (Default)		
I/O Ports	4x USB 3.2 Gen2, 2x COM, 2x 2.5GbE LAN, Line-out		
Expansion	1x M.2 E-Key (Wi-Fi 6E), antenna support		
Operating System	Windows 10/11, Ubuntu 22.04 / 24.04 LTS		
Power Input	12-36V DC, 60W AC adapter		
Operating Temperature	-10°C to 50°C		
Mounting Options	VESA 75/100, Panel Mount (optional)		


## AIO-200-MTL SERIES

MORE






NEW



NEW





NEW


Model	AIO-W210-MTL	AIO-W215-MTL	AIO-W221-MTL
Display Size & Resolution	10.1" 1280 x 800 (WXGA)	15.6" 1920 x 1080 (FHD)	21.5" 1920 x 1080 (FHD)
Brightness	400 nits	400 nits	500 nits
Touchscreen	PCAP, 10-point, 7H / IK07 + Glove Mode		
IP Rating	IP65		
Processor	Intel® Core™ Ultra 5 125U / Ultra 7 155U		
Memory & Storage	DDR5 up to 32GB + 128GB M.2 M-Key NVMe SSD		
I/O Ports	1x USB-C, 2x USB 3.2 Gen1, 1x USB 2.0, 2x COM, 3x 2.5GbE LAN, 2x DP		
Expansion	1x M.2 B-Key (4G/5G), 1x M.2 E-Key (Wi-Fi/Bluetooth), 1x SIM		
Operating System	Windows 10/11, Ubuntu 22.04 / 24.04 LTS		
Power Input	12-24V DC, 150W AC adapter		
Operating Temperature	-10°C to 50°C		
Mounting Options	VESA 75/100, Panel Mount (optional)		


## AIO-200-ASL SERIES

MORE









Model	AIO-W210-ASL	AIO-W215-ASL	AIO-W221-ASL
Display Size & Resolution	10.1" 1280 x 800 (WXGA)	15.6" 1920 x 1080 (FHD)	21.5" 1920 x 1080 (FHD)
Brightness	400 nits	400 nits	500 nits
Touchscreen	PCAP, 10-point, 7H / IK07		
IP Rating	IP65 (front bezel)		
Processor	Intel® N97 / x7835RE		
Memory & Storage	DDR5 up to 16GB + 128GB M.2 B-Key SSD (Default)		
I/O Ports	2x USB 3.2 Gen2, 2x COM, 3x 2.5GbE LAN, DP, HDMI		
Expansion	1x M.2 E-Key (Wi-Fi 6E), 1x M.2 B-Key (4G/5G/SATA), Dual SIM		
Operating System	Windows 10/11, Ubuntu 22.04 / 24.04 LTS		
Power Input	12-36V DC, 60W AC adapter		
Operating Temperature	-10°C to 50°C		
Mounting Options	VESA 75/100, Panel Mount (optional)		




# VIO SERIES





## IP65 MODULAR INDUSTRIAL TOUCHSCREEN COMPUTERS & MONITORS


### RUGGED IP65 MODULAR PANEL PC

The VIO Series modular touch display systems deliver an industrial-grade IP65 display solution designed specifically for HMI automation, information and communication applications. Its unique modular design makes the display system more flexible and versatile by providing a unique solution for both an industrial panel pc and a touch monitor.

- 

PCAP/Resistive Touch
- 

Modular Design
- 

Wide Operating Temperature
- 

Scratch-Resistant 7H Glass Screen

## DISPLAY MODULE

### VIO-200 SERIES [MORE](#)

The VIO-200 Series display module offers a diverse range of standard screen sizes, resolutions, and touch technologies. Designed for seamless integration, it is fully compatible with both the PC Modules and Monitor Module, enabling effortless configuration, upgrades, and maintenance.

#### 16:9

Thin Frame



Model	VIO-W215	VIO-W221	VIO-W224
LCD Size	15.6"	21.5"	23.8"
Max. Resolution	1920 x 1080 (Full HD)		
Brightness (cd/m2)	500 nits		450 nits
	1,000 nits (Optional)		
Contrast Ratio	1,000:1		
LCD Color	16.7M		
Life Cycle Time	50,000 Hours	30,000 Hours	
Viewing Angle (H-V)	178 / 178		
Internal Speaker	AMP 10W + 10W		
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Operating Temperature	-10°C to 60°C	-10°C to 50°C	

#### 4:3

Thin Frame



Model	VIO-212	VIO-215	VIO-217	VIO-219
LCD Size	12.1"	15"	17"	19"
Max. Resolution	1024 x 768 (XGA)		1280 x 1024 (SXGA)	
Brightness (cd/m2)	600 nits	350 nits		
	1,000 nits (Optional)			
Contrast Ratio	1000:1		800:1	1000:1
LCD Color	16.2M	16.7M		
Life Cycle Time	50,000 Hours			
Viewing Angle (H-V)	178 / 178	170 / 160	178 / 178	170 / 160
Internal Speaker	AMP 5W + 5W	AMP 10W + 10W		
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch			
Operating Temperature	-10°C to 60°C			-10°C to 50°C

VIO-300 SERIES

16:9  
Thin Frame



Model	VIO-W315	VIO-W321	VIO-W324
LCD Size	15.6"	21.5"	23.8"
Max. Resolution	1920 x 1080 (Full HD)		
Brightness (cd/m2)	500 nits		
	1,000+ nits (Optional)		
Contrast Ratio	1000:1		
LCD Color	16.7M		
Life Cycle Time	50,000 Hours		
Viewing Angle (H-V)	178 / 178		
Internal Speaker	2W		
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Operating Temperature	-10°C to 60°C		

4:3  
Thin Frame



Model	VIO-312	VIO-315	VIO-317
LCD Size	12.1"	15"	17"
Max. Resolution	1024 x 768 (XGA)		1280 x 1024 (SXGA)
Brightness (cd/m2)	600 nits	350 nits	
	1,000 nits (Optional)		
Contrast Ratio	1000:1		-
LCD Color	16.2M	16.7M	
Life Cycle Time	50,000 Hours		
Viewing Angle (H-V)	178 / 178	170 / 160	178 / 178
Internal Speaker	-	2W	
Touch Type	Resistive 5-wire Touch / Projected Capacitive Touch		
Operating Temperature	-10°C to 60°C		

MX100H [MORE](#)

- 12.1" ~ 23.8" Thin Frame Full Range Touch Monitors
- Projected Capacitive and 5-wire Resistive Touchscreen Available
- 9 to 48 VDC Wide Range Power Input
- Aluminum Die-casting Front Frame
- Front Panel IP65 Rating



Model	MX100H
VGA	1x VGA Input
HDMI	1x HDMI Input
DisplayPort	1x DisplayPort Input
USB	1x USB 2.0 Input
COM Port	1x COM Port Input (Resistive Touch Only)
Audio	1x Audio Input
Power	3-pin, AT/ATX 9-48V
Operating Temperature	-10°C up to 60°C (with display module)
Dimensions (WxDxH)	246 x 220 x 37 (mm)



PC100-EHL SERIES



MORE



Model	PC100-EHL	PC100-EHL-1
Processor	Intel® Celeron® J6413, 4 cores, 10W TDP, up to 3.0 GHz	
Memory & Storage	1x DDR4 SODIMM, Max. 32GB; 1x 2.5" SATA HDD bay; 1x mSATA; 2x SIM sockets	
Expansion	1x full-size Mini PCIe (USB2.0/SATA); M.2 E-Key (Wi-Fi); M.2 B-Key (PCIe x2 + USB3.2 Gen1)	Same as PC100-EHL plus 1x PCIe x4 slot (1-lane) and 1x Universal I/O Bracket
I/O & LAN	2x LAN (1x GbE + 1x 2.5GbE), 6x COM (4 external + 2 internal), USB 3.2 Gen2 & USB 2.0, DP, LVDS, Audio, 8x DI / 8x DO (isolated), CAN	Same I/O & LAN configuration

PC100-TWL



SERIES



Model	PC100-TWL
Processor	Intel® Processor N150 (4 cores, 6W)
Memory & Storage	1x DDR5 SO-DIMM 4800/5600 MT/s, Max. 32GB; M.2 M-Key NVMe SSD (Gen3 x2) + Hot-swap 2.5" SATA SSD
Expansion	M.2 B-Key (PCIe x1 / USB3.0, 4G/5G, Dual Nano SIM), M.2 E-Key (Wi-Fi), 1x PCIe Gen3 x1 (x4 open-end)
I/O & LAN	2x 2.5GbE LAN (Intel® i226-IT), 6x COM, USB 3.2 Gen2 Type-A & Type-C, DIO 8-in/8-out (isolated), CAN-FD
Power, OS & Environment	9-36V DC (AT/ATX), OVP/OCP/Reverse/Surge protection; Windows 10/11, Ubuntu 22.04/24.04 LTS; -20°C to 60°C operation

PC600-MTL

SERIES



Model	PC600-MTL	PC600-MTL-1E
Processor	Intel® Core™ Ultra 5 125U	
Memory	1x DDR5 5600 SODIMM, Max 32GB	
Storage	1x Hot-swap 2.5" SATA (RAID 0/1), 1x M.2 M-Key NVMe	
Display Output	1x DP 1.2, 1x HDMI 2.0b, 1x LVDS Compatible with VIO-300 Touch Display Module	
Expansion	2x M.2 B-Key + 1x M.2 E-Key	
PCIe Slot	-	1x PCIe x4 (4-lane)
I/O & LAN	2x 2.5GbE LAN, 2x USB 3.2 Gen1, 1x USB-C Gen2, 1x USB2 TYPE A, 6x COM (4 external + 2 internal), Audio, DIO 8-in/8-out with isolation, 2x CAN (Optional), 4x antenna holes, + 1x Universal I/O bracket for PC600-MTL-1E	
Operating System	Windows 10/11, Ubuntu 22.04 / 24.04 LTS	
Power Input	9-48V DC, AT/ATX mode, OVP/OCP/Reverse Protection	
Operating Temperature	0°C to 55°C	
Certifications	CE, FCC Class A, MIL-STD-810H (shock/vibration)	

# SIO SERIES



## IP66/69K STAINLESS STEEL INDUSTRIAL TOUCHSCREEN COMPUTERS

### SUS 316 WASHDOWN TOUCHSCREEN COMPUTER

The SIO Series unifies advanced compute capabilities, I/O expandability and interactive display for dynamic industrial deployments. The stainless steel SIO Series are designed fanless, strong and tightly sealed to sustain punishing temperatures, harsh impacts, caustic contact and intense equipment washdowns.



Optical  
Bonding



Wide  
Temperature



Shock And Vibration  
Resistance



**TPM**  
TPM 2.0 Security  
Module

IP66/IP69K WASHDOWN TOUCHSCREEN COMPUTER WITH FULL SUS316

## SIO-300-ADL SERIES [MORE](#)

intel



Model	SIO-315-ADL	SIO-W315-ADL	SIO-W321-ADL	SIO-W324-ADL
Processor	Intel® Processor N97 (up to 3.6 GHz, 4-core)			
Display Size & Resolution	15” 1024 x 768 (XGA)	15.6” 1920 x 1080 (FHD)	21.5” 1920 x 1080 (FHD)	23.8” 1920 x 1080 (FHD)
Brightness	450 nits		400 nits	450 nits
Touchscreen	PCAP, 7H hardness, IK07 impact rating, optical bonding			
Front IP Rating	Full System IP66 / IP69K, SUS316 stainless steel enclosure			
Memory	1x DDR5 4800MT/s SODIMM, up to 16GB (non-ECC)			
Storage	1x M.2 B key NVMe SSD		1x M.2 B key NVMe SSD 2.5” SATA SSD, Support	
Expansion	1x M.2 E-Key (Wi-Fi 6E), 2x Antenna Holes		1x M.2 B-Key (4G/5G) + 1x M.2 E-Key (Wi-Fi 6E), 4x Antenna Holes	
I/O Ports (M12)	3x 2.5GbE LAN (M12 X-code), 1x COM RS-232/422/485(Default RS232), 1x COM RS232 (M12 A-Code), 2x USB 2.0 (M12 A-code)			
Operating System	Windows 10/11, Ubuntu 22.04 / 24.04 LTS			
Power Input	110-240V AC, M12 S-code connector, ATX mode (Default)			
Operating Temperature	-10°C to 50°C (fanless)			
Certifications	CE, FCC Class A; MIL-STD-810H shock & vibration compliant			
Mounting Options	VESA 100x100 / 200x100, Yoke mount optional			



# INDUSTRIAL BOARD SOLUTIONS



## 1.8" SERIES

**FEMTO ITX**  
MINI INDUSTRIAL SBC

## MINI-ITX SERIES

**RICH I/O**  
INDUSTRIAL MOTHERBOARD

## 2.5" SERIES

**PICO ITX**  
COMPACT INDUSTRIAL SBC

## MICRO ATX SERIES

**RICH EXPANSIONS**  
INDUSTRIAL MOTHERBOARD

## 3.5" SERIES

**3.5-INCH**  
SFF INDUSTRIAL SBC

## ATX SERIES

**HIGH-PERFORMANCE**  
INDUSTRIAL MOTHERBOARD

Our line of industrial motherboards and single board computers represent the standard of embedded computing as well as the future of data processing and I/O connectivity. From OEM /ODM enterprise computing designs to embedded single board computer applications, We provide reliability and longevity with standard off-the-shelf industrial grade motherboards for the most challenging embedded deployments.

We also provide end-to-end engineering services to ensure your configuration requirements and solve your mechanical design challenges. From a full custom solution to a small change in the I/O, we can adapt each motherboard to comply with your specifications without compromising performance.



## INDUSTRIAL BOARDS

## BOARDS SERIES [MORE](#)

We offer industrial-grade scalability with standard motherboards and OEM system design. Standard form factors include: Single board computers (1.8" Femto-ITX, 2.5" PICO-ITX, and 3.5" SBCs); Mini-ITX; and Micro-ATX.

## 1.8" FEMTO ITX SERIES



Model	CT-NR101
CPU	AMD Ryzen™ Embedded R1606G with Radeon™ Vega 3 Graphics (3.5GHz/2 Core)
Memory	1x DDR4-2400 Single-Channel Memory 4GB (Up to 8GB, Optional)
Storage	eMMC up to 64GB
Display	2x Micro HDMI 1.4 (4K DCI)
Rear I/O	1x RJ45 (GbE) 1x Type C USB 3.1 Gen 1 (5V/3A) 2x 5-pin header DIO (4-in/4-out)
Internal I/O	1x USB 2.0 (4-pin header, internal)
Expansion	1x Full-size Mini PCIe (PCIe x1, USB 2.0) 1x SMBus
Operating Systems	Windows 10, Linux Kernel 5.x
Power	ACPI, DC IN 12V
Operating Temperature	0°C to 60°C
TPM	TPM 2.0
Dimension	84 x 55 mm

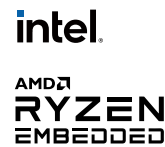
## 2.5" PICO ITX SERIES



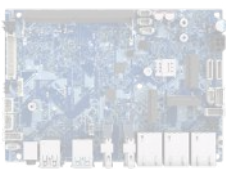
Model	CT-PBT01
CPU	Intel® Celeron Processor J1900 (2.0GHz/4 Core/10W)
Memory	1x 204-Pin DDR3L 1066/1333MHz SODIMM. Max. up to 8GB
Storage	1x SATA 3.0Gb/s 1x mSATA (shared by 1x Mini PCIe)
Display	1x HDMI (2048x1080 @60Hz) 1x LVDS
Rear I/O	1x USB 3.0, 1x USB 2.0 1x RJ45
Internal I/O	1x RS-232/422/485, 1x RS-232 2x USB 2.0 1x 8-bit GPIO (4-in/4-out)
Expansion	1x Half-size Mini PCIe 1x Half-size Mini PCIe (Full-size optional)
Operating Systems	Windows 10, Windows 7, WES7 Linux kernel 3.X
Power	ACPI, DC IN 12V
Operating Temperature	-10°C to 70°C
TPM	N/A
Dimension	100 x 72 mm

BOARDS 3.5” SBC SERIES

MORE



Model	CT-DR101	CT-DAL01	CT-DAL11
Processor	AMD Ryzen™ Embedded R1000/V1000 Series	Intel® N97 / Intel® Core i3-N305	Intel® N97 / Intel® Atom® x7835RE
Memory	2x DDR4 SODIMM, Max 32GB	1x DDR5 SODIMM, Max 16GB	1x DDR5 SODIMM, Max 16GB
Storage	1x M.2 B-Key (SATA), 1x SATA	1x SATA	1x SATA
Expansion	1x Full-size Mini PCIe, 1x M.2 B-Key	1x M.2 B-Key, 1x M.2 E-Key	1x M.2 B-Key (SATA/PCIe/USB3), 1x M.2 E-Key
I/O & LAN	2x GbE, DP, HDMI, 2x USB 3.2 Gen2, 2x USB 2.0, 2x COM	2x 2.5GbE, DP, HDMI, 2x USB 3.2 Gen2, 2x USB 3.2 Gen1, 4x USB2.0, 2x COM	3x 2.5GbE, DP, HDMI, eDP, 2x USB 3.2 Gen2, 2x USB2.0, Dual Nano SIM, 2x COM



Coming Soon

Model	CT-DAS01 / CT-DAS02	CT-DML01	CT-DPLO1
Processor	<ul style="list-style-type: none"><li>CT-DAS01: Intel® X7433RE/X7835RE Wide Temperature</li><li>CT-DAS02: Intel® N150</li></ul>	Intel® Core™ Ultra 5 125U / Ultra 7 155U	Intel® Core™ Ultra Series 3 (Panther Lake-H), 25W
Memory	1x DDR5 4800 SODIMM (Max 16GB)	1x DDR5 5600 SODIMM (Max 32GB)	1x DDR5 SO-DIMM, (Max 128GB)
Storage	1x M.2 M-Key NVMe + 1x SATA (share with B Key)	1x M.2 M-Key (NVMe/SATA Auto-Detect)	1x M.2 M-Key 2280, PCIe Gen4 x4 NVMe
Expansion	M.2 B-Key (NVMe/4G/5G), M.2 E-Key (Wi-Fi/BT)	M.2 B-Key (4G/5G), M.2 E-Key (Wi-Fi/BT)	M.2 E-Key (Wi-Fi/BT), M.2 B-Key (4G/5G), Dual Nano SIM
I/O & LAN	2x 2.5GbE, DP, HDMI, USB-C, 3x USB 3.2, COM, DIO	3x 2.5GbE, 2x DP, USB-C, USB 3.2, COM, DIO, Dual SIM	3x 2.5GbE, USB-C + PD, DP, USB 3.0, 4x COM, GPIO, Audio

BOARDS MINI ITX SERIES

MORE



Coming Soon

Model	CT-XRL02	CT-XAR01
Processor	Intel® 12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Core™ i9/i7/i5/i3 (65W, LGA1700)	Intel® Arrow Lake-S Core Ultra 9/7/5 Series (65W, LGA1851)
Chipset	Intel® Q670E	Intel® W880
Memory	2x DDR4 3200 SODIMM, max 64GB	2x DDR5 5600 SODIMM, ECC/Non-ECC, max 96GB
Display Output	2x DP, 1x HDMI (Triple Display)	2x DP, 1x HDMI, 1x LVDS/eDP (Quad Display)
Storage	1x M.2 M-Key NVMe (Gen3), 3x SATA 6Gb/s (RAID 0/1/5)	1x M.2 M-Key (NVMe/SATA, 2280), 2x SATA 6Gb/s (RAID 0/1)
Expansion	1x PCIe x16 (Gen4 via golden-finger riser), 1x M.2 E-Key, 1x M.2 B-Key (with Nano SIM)	1x PCIe x16 (Gen5), 1x M.2 E-Key, 1x M.2 B-Key
LAN	3x 2.5GbE (Intel® I226 series)	
I/O Ports	6x USB 3.2 Gen2, 2x USB 3.2 Gen1 (internal), 2x USB2.0 (internal), 2x COM RS-232/422/485, Audio	6x USB 3.2 Gen2, 2x COM RS-232/422/485, Audio Line-out/Mic-in
Operating System	Windows 10/11, Linux Kernel	Windows 10/11 IoT Enterprise, Ubuntu 22.04/24.04 LTS
Power Mode	ATX 24-Pin + 12V-8Pin	ATX 24-Pin
Environment & Certification	0°C to 60°C, CE, FCC Class A	0°C to 60°C, CE, FCC Class A, UKCA
Form Factor	170 x 170 mm	



BOARDS MICRO ATX SERIES

MORE



Coming Soon



Model	CT-MRL01	CT-MBL01
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i9/i7/i5/i3 (65W, LGA1700)	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ Ultra / Core™ (Alder Lake-S / Raptor Lake-S / Bartlett Lake-S), up to 65W
Chipset	Intel® Q670E	
Memory	4x DDR4 DIMM (2133–2666MHz), max 128GB	4x DDR5-4400 UDIMM, max 128GB
Display Output	4x DP++ (quad-display support)	4x DP++ (quad-display support)
Storage	2x M.2 M-Key NVMe/SATA (2242/2260/2280), 4x SATA 6Gb/s	2x M.2 M-Key NVMe/SATA (2242/2260/2280), 4x SATA 6Gb/s
Expansion Slots	1x PCIe x16 Gen5, 1x PCIe x16 Gen4 (4-lane), 1x PCIe x4 Gen4, 1x PCIe x4 Gen3	1x PCIe x16 Gen5, 1x PCIe x16 Gen4 (4-lane), 1x PCIe x4 Gen4, 1x PCIe x4 Gen3
LAN	1x 1GbE (Intel® I219LM), 1x 2.5GbE (Intel® I225-V)	2x 2.5GbE (Intel® I226 series)
I/O Ports	6x USB 3.1 Gen2, 1x USB-C Gen2x2, 2x USB 3.0 (internal), 4x USB 2.0 (internal), 6x RS-232, Audio, 8-bit DIO	6x USB 3.1 Gen2, 1x USB-C Gen2x2, 2x USB 3.0 (internal), 4x USB 2.0 (internal), 6x RS-232, Audio, 8-bit DIO
Operating System	Windows 10/11, Linux Kernel 5.x	Windows 11 IoT, Ubuntu 22.04/24.04
Power	ATX power, ACPI 5.0, dual 12-pin + 2-pin headers	ATX power, ACPI 5.0, dual 12-pin + 2-pin headers
Environment & Certifications	Operating: 0°C to 60°C; Storage: –40°C to 85°C; 10–90% RH; CE, FCC Class B	Operating: 0°C to 60°C; Storage: –40°C to 85°C; 10–90% RH; CE, FCC Class B
Form Factor	244 x 244 mm	

BOARDS ATX SERIES

MORE



Coming Soon



Model	CT-ARL01	CT-AR701
Processor	12 <sup>th</sup> /13 <sup>th</sup> /14 <sup>th</sup> Gen Intel® Core™ i9/i7/i5/i3, Pentium®, Celeron® (LGA1700), up to 125W TDP.	AMD Ryzen™ 9000/8000/7000 Series Desktop CPUs & EPYC™ 4004 (Socket AM5), up to 170W TDP
Chipset	Intel® R680E Express Chipset.	AMD B650
Memory	4x DDR5 4400 ECC/non-ECC UDIMM slots, up to 128GB.	4x DDR5 UDIMM, dual-channel, up to 256GB (DDR5 5200 MT/s 1DPC)
Display Output	3 independent displays: 1x DP (4096x2160@60Hz), 1x HDMI (4096x2304@60Hz), 1x VGA (1920x1200@60Hz).	1x DP 1.4a (4096x2160@60Hz), 1x HDMI 2.0 (4096x2160@60Hz); dual independent displays
Storage	4x SATA 3.0 (RAID 0/1/5/10), 2x M.2 M-Key (1 from CPU, 1 shared with PCIe Slot 5).	4x SATA 3.0 (AHCI), 1x M.2 M-Key (2242/2280)
Expansion Slots	PCIe Slots: 2x PCIe x16 (Gen5, configurable as x16 or dual x8), 4x PCIe x4, 1x PCIe x1.	2x PCIe x16 (Gen5/Gen4, x16 or dual x8), 1x PCIe x4 (open-end), 2x PCIe x1
M.2 Expansion	M.2 Slots: 1x M-Key, 1x E-Key (PCIe x1), 1x B-Key (PCIe x2).	1x M.2 M-Key (PCIe x4, NVMe), 1x M.2 E-Key 2230 (PCIe x1 + USB 2.0)
LAN	4x 2.5GbE (Intel® I225-LM).	2x 1GbE (Intel® I210AT, RJ-45) + 2x 10GbE (Broadcom BCM57412, SFP+)
I/O Ports	Rear I/O: 8x USB 3.2 Gen2, 1x DP, 1x HDMI, 1x VGA, 1x Mic-in, 1x Line-out, 1x PS/2.	Rear: USB 3.2 Gen2 Type-A, DP+HDMI stack, Audio jack, LAN; Internal USB headers supported
Internal I/O	Internal: 2x USB 3.2 Gen1, 3x USB 2.0, 6x COM (RS-232/422/485), GPIO (16-bit), SMBus, I C, PMBus.	6x COM, multiple USB headers, TPM 2.0, GPIO, fan headers, OOB connector, watchdog
Operating System	Windows 10 IoT Enterprise 2021 LTSC, Windows 11 IoT Enterprise 22H2, Linux Kernel 5.xx, Ubuntu 22.04 LTS.	Windows 11 (Ryzen 7000/8000), Linux Kernel 5.x, Ubuntu 22.04 LTS (pre-scan)
Power	ATX-Power 24-Pin + 12V-8Pin; ACPI 5.0; Watchdog Timer; TPM 2.0 (Infineon SLB9672).	ATX power: 24-pin ATX + 8-pin 12V, AT/ATX selectable
Environment & Certifications	Operating Temp: 0 to 60°C; Storage: -20 to 80°C; Humidity: 10-90% RH.	Operating 0 to 60°C, Storage -20 to 80°C, 10-90% RH (non-condensing)
Certifications	Certifications: CE, FCC Class-B, DSMTI, RCM, VCCI.	CE, FCC Class B, RoHS compliant
Form Factor	305 x 244 mm	

\* The CT-ARL01 Series is available exclusively in the North Americas, contact sales@premioinc.com for more information.



**INDUSTRIAL COMPUTING SOLUTIONS**

**JMD** 株式会社ジェイ・エム・ディー  
<https://www.j-m-d.co.jp/>

---

本社：〒113-0034 東京都文京区湯島1-9-3 ユーメリアビル 2F

TEL：03-6256-8955 FAX：03-6256-8958

西日本営業部：〒651-0086 兵庫県神戸市中央区磯上通4-3-10 IPSX EAST 7F

TEL：078-261-3010 FAX：078-261-3810